## HP Engage One Pro G2 All-In-One system

### **FRONT VIEW**

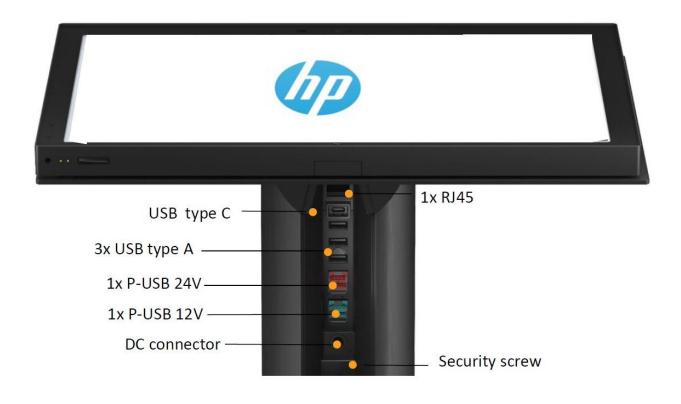


## **REAR VIEW**

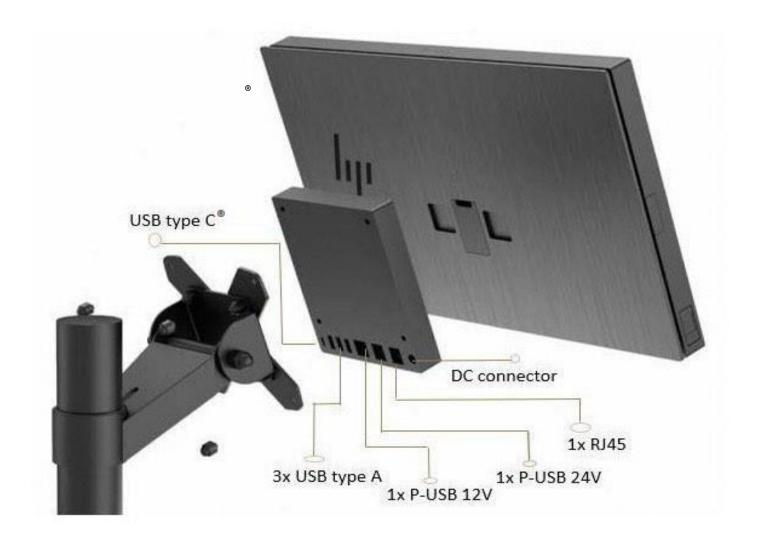




## **HP Engage One Pro G2 Column hub**



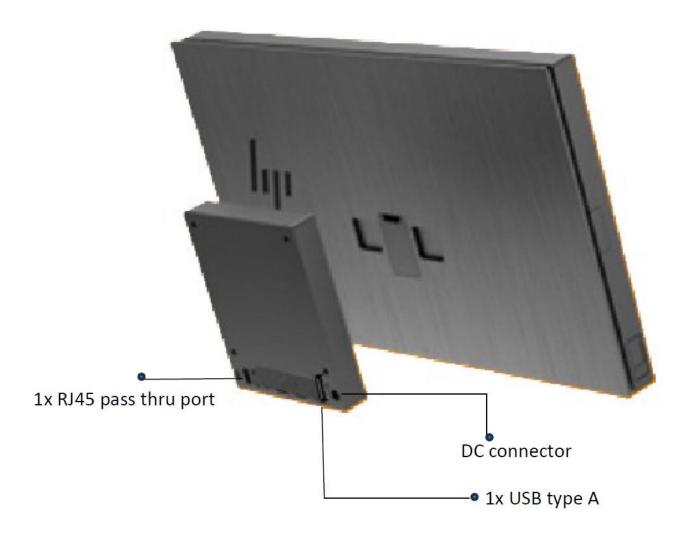
## HP Engage One Pro G2 VESA hub



## HP Engage One Pro G2 Advanced Fan-less Hub



## **ENGAGE ONE PRO USB-A (HUB-LESS) DONGLE**



Overview

## **Component Breakdown**

- Head unit screen sizes: 3 Choices 15.6", 19.5", 23.8"
   Landscape or portrait orientation
- 2. Stand: 3 choices:
  Advanced stand,
  Pro stand,
  Slim VESAwall mount

- 3. Stability Base Plate or Counter mount & U-Shape Adapter
- 4. Hub: 4 Options based on I/ O requirements:
  Column hub
  Advance hub,
  VESA mount hub,
  Hub-less

Not shown: Head unit connects with hub through a 140W Cable with secure screwed to connectivity base



### **Component Breakdown**

## **HP Engage One Pro G2 Stand Features**

- 1. Advanced Stand-Dual hinge with 12º vertical associate side flip to 140º on customer side
- 2. Engage One Pro stand- tilt 40° 120°

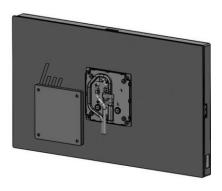




## **Component Breakdown**

## **HP Engage One Pro G2 Stand Features**

3. HP Engage One Pro G2 AiO Slim VESA mount (100x100mm)





4. HP Engage One Pro G2 AiO Advanced\* Stand Clean Counter Mount No stability plate- includes Counter Mounting Bracket\*\* (Requires 94mm hole)

5. HP Engage One Pro G2 AiO System Advanced\* stand with Stability Base Plate





### Overview

### At A Glance

- Choice of 2 colors: Ebony Black &Ceramic White\*
  - \*White only available in 15.6" and 23.8"
- Choice of 2 orientations: Landscape &portrait
- With or without Camera
- Choice of 3 Long lifecycle performance All-in-One (AiO) Retail System for retail and hospitality markets operator display:
  - 15.6" diagonal, FHD(1920 x 1080), touch, IPS, UWVA, anti-glare, 400 nits, 45% NTSC
  - 19.5" diagonal, FHD(1920 x 1080), touch, VA, UWVA, anti-glare, 450 nits, 72% NTSC
  - 23.8" diagonal, FHD(1920 x 1080), touch, IPS, UWVA, anti-glare, 625 nits, 72% NTSC
    - NOTE: Actual brightness will be lower with touch screen
- Choice of 2 column stand:
  - HP Engage One Pro G2 Advanced stand
  - o HP Engage One Pro stand
- Choice of Mounting:
  - Clean counter- Place the connectivity hub under the counter
  - All together- Place the hub directly under the stand
  - o Slim VESAwall mount- Place the head unit on the wall
  - Pole mount--Place the head unit on a single or back-to-back pole
- Intel®Q670E chipset, 35WProcessors
- Processor choices:

Intel® Celeron® G Series

Intel®Celeron®G6900TE

#### Intel® Core™ 14th Generation

- o Intel®Core™ i3 14th generation processor
- o Intel®Core™ i5 14th generation processor
- o Intel®Core™ i7 14th generation processor" Intel®Pentium®processor
- Integrated: Intel®UHDGraphics 710 on Celeron &Pentium; Intel®UHDGraphics 730 on i3 and i5, Intel®UHD Graphics 770 on i7
- Intel®Ethernet Connection Intel® I219-LM GbE, vPro® integrated network connection from head unit
- RTL8153CH Ethernet Connection from Advanced hub
- o Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro®;
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, non-vPro®
- Intel WI-FI 6E AX211 WI-FI 6E and Bluetooth® 5.3 wireless card, non-vPro®
- Operating System choices:
  - Windows 11 Pro 64-bit / Windows 10 IoT Enterprise 2021 LTSC64 / Windows 11 IoT Enterprise 2024 LTSC64
  - o FreeDOS 3.0
  - SUSE Linux®Enterprise Server 15
  - Google ChromeOS Flex
- Connectivity Base Choices
  - o HP Engage One Column hub:
  - o HP Engage One VESAhub
  - o HP Engage One Advanced Fan-less hub
  - o Hub-less
- Integrated peripheral options (can also be purchased and installed separately)
- HP Engage One Pro MSR
- HP Engage One Pro G2 Bar Code Scanner (choose between 3 locations: left, right, bottom) of the head unit
- HP Engage One Pro Fingerprint Reader
- HP Engage One Pro 6x6 Customer facing display with 2x20 line display emulation \*\*
  - \*\*The 2x20 line display emulation can be used on 6.6" CFD and future CFDs for Engage One Pro Virtual Line Display will work with any display. It defaults to 2x20, it can also be used for any other size line display such as 3x16 or 3x20, 5x10
- Virtual Line Display will work with any display. It defaults to 2x20,, it can also be used for any other size line display such as 3x16 or 3x20, 5x10
- Industry-standard 100mm VESA mounting pattern allows for flexible use without the optional stand (Mounting hardware sold separately)



### Overview

- (2) Two DDR5 Memory Slots (64 GB Maximum)
- Trusted Platform Module (TPM2.0)
- HP BIOSphere with HP Sure Start technology
- Cable Management Features-RJ45 extension
- ENERGYSTAR®certified configurations available, EU Compliant, RoHS2 Compliant, EPEAT®registered configurations available
- Standard Warranty Options 90/ 90/ 90, 1/ 1/ 1, 3/ 3/ 3; Plus Optional Care Packs
- 2 SODIMM Memory slots with up to 64 GBDDR5 SDRAM Transfer rates up to 5600 MT/s.
- 1x M.2 WLAN expansion slot
- 2xM.2 Storage slots
- 256 GBto up to 4 TB PCle® NVMe SSDfistdrive
- 256 GBto up to 4 TB PCIe® NVMe SSDseconddrive
- Integrated HD audio with Realtek ALC3247 codec with standards internal speakers and stereo headphone jack, 2W)
- HP Credential Guard; HP Device Guard; HP Support Assistant; HP BIOSphere with Sure Start Generation 6.0
- HP Sure Sense; HP Sure Click (Standard); HP Sure Admin; HP MIK(SCCM Integration); HP Image Assistant; HP BIOSphere with Sure Start Gen6; HP Client Security Manager Gen7; HP Sure Recover Gen3; HP Sure Run Gen3
- Intel® vPro® with AMT11.0;TPM2.0;HP System Software Manager; HP Image Assistant; HP Client Security Manager
- Display head Ports and Connectors: 1 audio-out; 2 USBType-A5Gbps signaling rate; 2 USB Type- A 5Gbps signaling rate (HP Sleep and Charge); 1 RJ-45 USBNIC;1 140Wdata port Side: 1 Security lock slot
- Choice of 3 connectivity hubs:
  - o HP Engage One Pro G2 Column hub:
    - 3x USB Type-A 5Gbps signaling rate
    - 1x RJ-45 NIC
    - 1x DCconnector
    - 3x USB 2.0 Type-A
    - 1x USB Type-C<sup>®</sup> 5Gbps signaling rate (27 WPower Delivery, Alt Mode DisplayPort™)
    - 1x 140Wdata port
    - 1x P-USB 12V
    - 1x P-USB 24V
  - HP Engage One Pro G2 VESA hub:
    - 3x USB Type-A 5Gbps signaling rate
    - 1x RJ-45 NIC
    - 1x DCconnector
    - 3x USB 2.0 Type-A
    - 1x USB Type-C<sup>®</sup> 5Gbps signaling rate (27 WPower Delivery, Alt Mode DisplayPort™)
    - 1x 140Wdata port
    - 1x P-USB 12V
    - 1x P-USB 24V
  - o HP Engage One Pro G2 Advance fan-less hub
    - 1x cash drawer connector
    - 2x power serials
    - 4x USB Type-A 5Gbps signaling rate
    - 1x RJ-45 NIC
    - 1x DCconnector
    - 1x USB Type-C®5Gbps signaling rate (27 WPower Delivery, Alt Mode DisplayPort™)
    - 1 x140Wdata port]
    - 2x P-USB 12V
    - 1x P-USB 24V
  - Combination of Advance hub with Column hub; Combination of Advance hub with VESA hub.
  - HP Engage One Pro G2 Hub-less
    - 1x USB type-A port and 1xRJ45 pass thru port

NOTE: See important legal disclosures for all listed specs in their respective features sections.



### Overview

#### **SECURITY DISCLAIMERS:**

HP Essential Security requires Windows 10, includes various HP Sure security features and is available on HP Elite and Workstation products. See product details for included security features.

HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

HP Sure Recover Gen3 is available on select HP PCs and requires an open network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. HP Sure Recover Gen3 requires an open network connection. You must back up important files, data, photos, videos, etc. before use to avoid loss of data.

HP Sure Start Gen6 is available on select HP PCs.

HP Sure Click is only supported on Intel Core i3, i5, and i7 processors.

HP Sure Click, Sure Run, Sure Recover & Sure Sense is supported on Win 10 Pro & Win 10 IoT Enterprise 2019 LTSC; but not on Win 10 IoT Enterprise 2016 LTSB.

For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

HP BIOSphere Gen6 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.



**Features** 

### **OPERATING SYSTEM**

**Preinstalled** Windows 11 Pro 64-bit <sup>1</sup>

Windows 10 IoT Enterprise 2021 LTSC Windows 11 IoT Enterprise 2024 LTSC

Google ChromeOS Flex

FreeDOS 3.0

**Certified** SUSE Linux®Enterprise Server 15<sup>2</sup>, Redhat

#### **NOTE:**

 Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com

2. SUSE Enterprise Linux 15 SP2 YES Certification on a single platform configuration. More information about SUSE

YES certification on https://www.suse.com/partners/ihv/yes/

The following features are not supported by SUSE Linux Enterprise Desktop:

- Power Management features
- Multi-touch capabilities
- Systems configured with Linux do not qualify for ENERGY STAR®
- 3. Only available on certain configurations (please ask sales representative)

## **Adapters and Cables**

- HP USB-C® to DisplayPort
- HP USB-C® to HDMI
- HP USB-C® to VGA
- USB to Serial Port Adapter

## **NETWORKING/COMMUNICATIONS**

- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro®;\*, \*\*
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, non-vPro®;\*, \*\*
- Intel WI-FI 6E AX211 WI-FI 6E and Bluetooth® 5.3 wireless card, non-vPro®;\*, \*\*
- Realtek RTL8153CH 10/100/1000MGbE Lan Chip:
  - o Supports Ethernet speeds: 10Mbps, 100Mbps, and 1Gbps
  - o USB Interface: USB 3.0 for faster data transfer rates compared to USB 2.0
  - Auto-negotiation: Automatically negotiates the best speed (10Mbps, 100Mbps, or 1Gbps) with a connected device
  - o Compact size: USB form factor makes it suitable for laptops and desktops with limited space
  - o Power Management: Supports features like ACPI and Wake-on-LAN for efficient power consumption

\*Wireless access point and Internet service required and not included. Availability of public wireless access points limited. The specifications for the 802.11ax WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the PC to communicate with 802.11ax WLAN devices. Wi-Fi 7 requires a wireless router, sold separately, that supports 802.11be (Wi-Fi 7). Only available in countries where 802.11be is supported.



#### **Features**

\*\* Wi-Fi 7 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

\*\*\*Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 7 (802.11be) is backwards compatible with prior 802.11ax (Wifi6)specs.

## **NEAR FIELD COMMUNICATION**

NXP NPC300 Near Field Communication Module

### **PORTS**

#### HP Engage One Pro G2 Head unit I/O:

- 1x 140W data port (PDO cable to Head Unit)<sup>1</sup>
- 1x RJ45 vPro NIC
- 1 x 3.5mm Audio Jack support CTIA type
- 4x Integrated USB-A Gen1 Peripherals ports
- 2x USB3.2 G1 Type-A / 900mA
- 2x USB3.2 G1 Type-A / 2.2A

Internal access door for the SSD and USB-Port Type A on Motherboard Dimensions for USB-Port Type A: 55mm L includes plug / 16mm W / 8mm

### HP Engage One Pro G2 Column hub I/O

- 3x USB3.2 G2 Type-A / 900mA
- 1x RJ45 (cable direct from Head unit)
- 1x DC connector
- 1x P-USB 12V
- 1x P-USB 24V
- 1x USB3.2 G1 Type-C® DP Alt Mode / 27W
- 1x 140W data port (PDO cable to Head Unit)1

### HP Engage One Pro G2 VESA hub I/O

- 3x USB3.1 G1 Type-A / 900mA
- 1x RJ45 (cable direct from Head unit)
- 1x DC connector
- 1x P-USB 12V
- 1x P-USB 24V
- 1x USB3.2 G1 Type-C<sup>®</sup> DP Alt Mode / 27W
- 1x 140W data port (PDO cable to Head Unit) <sup>1</sup>

### HP Engage One Pro G2 Advanced Fan-less hub I/O

- 1x RJ12 Cash Drawer
- 2x 12V P-USB
- 1x 24V P-USB
- 2x DB9 P-Serial
- 4x USB3.2 G1 Type A/900mA
- 1x RJ45 USB NIC
- 1x DC connector
- 1x USB 3.1 G2 Type-C® DP Alt Mode / 27W
- 1x 140W data port (PDO cable to Head Unit) <sup>1</sup>

#### HP Engage One Pro G2 Hubless I/ O

- 1x USB Type A
- 1x DC connector



#### **Features**

1x RJ45 NIC

**NOTE 1:** HP 140W port only compatible with the 140W cable included with the product. Cable required for the HP Engage One Pro G2 to operate

### **USB SPECIFICATION**

SpeedTerminologyHi-Speed USB 480Mbps signaling rateUSB 2.0USB 5Gbps signaling rateUSB 3.2 Gen 1

## **SOFTWARE COMPONENTS AND APPLICATIONS**

#### **BIOS**

- HP BIOSphere Gen6
  - Protect and manage the foundation of your POS System
  - Building on over a decade of BIOS security leadership, HP BIOSphere Gen6 offers an ecosystem of protections to help defend your system, including automated protections, customizable safeguards, and easy manageability
- HP Secure Erase<sup>1</sup>
- Device Guard Enablement

#### **Additional features of the HP BIOS Features**

Power-On password

#### Software

- HP Privacy Settings
- HP Setup Integrated 00BE
- HP Easy Clean<sup>2</sup>
- HP Notifications
- myHP

#### **Manageability Features**

- HP Driver Packs
- HP Manageability Integration Kit<sup>3</sup>
- HP Image Assistant
- HP Smart Support<sup>4</sup>

### Notes:

- 1. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
- 2. HP Easy Clean requires Windows and will disable the keyboard, display and touchpad only. Ports are not disabled.
- 3. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 4. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: http://www.hp.com/smart-support. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

## **Security Management**

- HP BIOSphere Gen 6<sup>1</sup>
- HP Client Security Manager Gen7<sup>6</sup>



#### **Features**

- HP Multi-Factor Authenticate -
- HP SpareKey -
- HP Sure Start<sup>6</sup>
- HP Sure Run<sup>4</sup> -
- HP Sure Recover<sup>4</sup>-Recover quickly and minimize downtime
  - Driven by the HP Endpoint Security Controller, HP Sure Recover enables users to reimage their systems quickly and securely using only a network connection – no IT intervention needed.

#### **Other Security Features**

- HP Engage One AiO System Biometric Fingerprint Reader (optional)
- Bolt to counter mechanism
- VESA mounting
- Keyed Cable Lock
- Trusted Platform Module TPM 2.0
- Drive lock
- USB enable/disable (via BIOS)
- Power-on password (via BIOS)
- Setup password (via BIOS)
- Tamper Resistant Screw affixed on stand of the system unit, used to secure display head to stand without Quick Released
- HP vPRO Support

#### **Notes:**

- 1. HP BIOSphere Gen6 features may vary depending on the platform and configuration.
- 2. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation
- agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be
  purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The
  Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:
   http://www.absolute.com/company/legal/agreements/computrace- agreement. Data Delete is an optional service
  provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data
- 4. HP Sure Click, Sure Run, Sure Recover & Sure Sense is supported on Win 10 Pro & Win 10 IoT Enterprise 2019 LTSC; but not on Win 10 IoT Enterprise 2016 LTSB.
- 5. HP Client Security Manager Gen7 requires Windows
- 6. HP Sure Start Gen6 is available on select HP PCs.

### **PROCESSORS**

- Intel® Celeron® G6900TE with Intel®UHD710 Graphics (2.4 GHz P-core base frequency, 4 MB L3 cache, 2 P-cores, 2 threads)
- Intel® Core™ i3-14100T with Intel UHDGraphics 730 (2.7 GHz P-core base frequency, up to 4.4 GHz P-core Max Turbo frequency, 12 MB L3 cache, 4 P-cores and 0 E-cores, 8 threads)
- Intel® Core™ i5-14500T with Intel UHD770 Graphics (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.4 GHz E-core Max Turbo frequency, up to 4.8 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel® vPro® Technology
- Intel® Core™ i7-14700T with Intel UHDGraphics 770 (0.9 GHz E-core base frequency, 1.3 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel® vPro® Technology

#### PROCESSORS FAMILY

14<sup>th</sup> Gen 35W Intel Core™ processors



#### **Features**

#### **NOTES:**

- 1. Multi-core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a mea configuration surement of higher performance.
- 2. Intel® Turbo Boost technology requires a PC with a processor with Intel Turbo Boost capability. Intel Turbo Boost performance varies

depending on hardware, software and overall system. See http://www.intel.com/technology/turboboost for more information.

3. For full Intel® vPro® functionality, Windows 10 Pro 64 bit, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or WLAN card and TPM 2.0 are required. Some functionality requires additional 3rd party software in order to run. See http://intel.com/vpro



## Technical Specifications

## INTEL® 14th GENERATION CORE™ vPRO® PROCESSORS

Intel®Core™ i5-14500T with Intel UHD770 Graphics (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.4 GHz E-core Max Turbo frequency, up to 4.8 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel® vPro® Technology

Intel®Core™ i7-14700T with Intel UHDGraphics 770 (0.9 GHz E-core base frequency, 1.3 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel® vPro® Technology

The HP Engage One Pro G2 AiO System Retail System features this technology and includes processors that are part of the Intel® Stable Image. Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP Engage One Pro G2 AiO System Retail System.

### Intel® Advanced Management Technology (AMT) v11.6

An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state.

- AMT 11.6 includes the following advanced management function
- Power Management (on, off, reset
- · Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/USBR
- Cisco NAC/SDN Support
- ME Wake-on-LAN DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc. by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- · Host-based set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution

\*Some functionality of this technology, such as Intel Active management technology and Intel Virt ualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro® technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" is yet to be determined.

\*\* Intel®Active Management Technology requires an Intel®AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. It may also require modifications of implementation of new business processes.



## Technical Specifications

## **OPERATOR DISPLAY\***

15.6" Diagonal Wide Aspect, Projective Capacitive, Anti-glare, Anti-smudge, IPS Display with Projective Capacitive

Touch

**Touch Technology** Projected Capacitive Touchscreen

**Resolution** 1920 x 1080

Aspect Ratio 16:9 Max Color 16.2M

Brightness Typical 400 Nits\*
Contrast Ratio Typical 800:1

**Pixel Pitch** 0.17925 x 0.17925mm

Viewing Angle Horizontal 178°, Vertical 178°

**Response rate** 25ms (Typical On / Off)

Backlight LED

**Operating Temperature range** 0 to 50°C (+ 50°C as panel surface temperature)

19.5" Diagonal Wide Aspect, Projective Capacitive, Anti-glare, Anti-smudge, UWVA, VA Display, with discrete Projective Capacitive Touch

**Touch Technology** Projected Capacitive Touchscreen

**Resolution** 1920 x 1080

Aspect Ratio 16:9
Max Color 16.7M

 Brightness
 Typical 450 Nits\*

 Contrast Ratio
 Typical 3000:1

 Pixel Pitch
 0.2265 x 0.2210mm

Viewing Angle Horizontal 170°, Vertical 170°
Response rate 25ms (Typical On / Off)

Backlight LED

**Operating Temperature range** 0 to 50°C (+ 50°C as panel surface temperature)

23.8" Diagonal Wide Aspect, Projective Capacitive, Anti-glare, Anti-smudge, IPS Display with discrete Projective Capacitive Touch

**Touch Technology** Projected Capacitive Touchscreen

**Resolution** 1920 x 1080

Aspect Ratio 16:9
Max Color 16.7M

**Brightness** Typical 625 Nits\*

Contrast Ratio 1000:1

**Pixel Pitch** 274.5 um x 2274.5 um

Viewing Angle Horizontal 178°, Vertical 178°

**Response rate** 14ms (Typical On / Off)

Backlight LED

**Operating Temperature range** 0 to 50°C (+ 50°C as panel surface temperature)

\*NOTE: Nits is the measure of the typical brightness of the panel as specified, prior to anti-glare coating

\*NOTES:



## QuickSpecs

## **Technical Specifications**

Portrait Display. With a Portrait Head Unit, the pre-OS environment will be displayed 90° in Landscape. Once the Windows OS loads, then the display will show Portrait.

\*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.



## **Technical Specifications-Graphics**

## Intel® HD Graphics (integrated)

## **Integrated Graphics**

Intel®UHDGraphics770 (integrated on 14<sup>th</sup> gen Core i7/ i5 Intel®UHDGraphics730 (integrated on 14<sup>th</sup> gen Core i3 Intel®UHDGraphics 710 (integrated on G Series Celeron®G6900TE)

## **DisplayPort**

DisplayPort over the optional USB-C® module

## **Memory**

The actual amount of maximum graphics memory can be >6GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory USE

## **Maximum Graphic Memory**

Windows 10 > 6 GB

## **Maximum Color Depth**

64bits/ pixel

10<sup>th</sup> Generation Intel®Core™ processors:

- Next Generation Intel®Clear Video Technology HDSupport is a collection of video playback and enhancement features that improve the end user's viewing experience
  - o Encode/ transcode HDcontent
  - Playback of high-definition content including Blu-ray Disc
  - o Superior image quality with sharper, more colorful images

## **Graphics/Video API Support**

- DirectX Video Acceleration (DXVA) support for accelerating video processing o Full AVC/VC1/MPEG2/HEVC HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 11. Linux OS Support
- DirectX 12.1
- OpenGL 4.4
- Open CL 1.2 (Intel® HD Graphics 730)
- Open CL 1.2/2.0 (Intel® HD Graphics 710)

**NOTE:** the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

#### **Supported Display Resolutions and Refresh Rates**

NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate
640x480	60Hz640x48067Hz
640x480	72Hz
640×480	75Hz
720x400	70Hz
800x600	60Hz



## **Technical Specifications-Graphics**

800x600	75Hz
1024x768	60Hz
1024x768	75Hz
1280x960	60Hz
1280x720	60Hz
1280x1024	60Hz
1280x1024	75Hz
1440×900	60Hz
1440×900	75Hz
1680x1050	60Hz
1920x1080	60Hz
3440x1440	60Hz 3440x144030Hz
2048x1536	60Hz
4096x2160	60Hz
4096x2160	60Hz



## Technical Specifications-Memory

## **MEMORY**

Туре

DDR5-5600 SODIMM (transfer rates up to 5600 MT/s)

Maximum

64 GB

# of Slots

2 SODIMM

## **Memory Upgrades**

- RAM8GB (1x8GB) DDR5 5600
- RAM8GB (1x8GB) DDR5 5600 PRC
- RAM16GB (1x16GB) DDR5 5600
- RAM16GB (2x8GB) DDR5 5600
- RAM16GB (1x16GB) DDR5 5600 PRC
- RAM16GB (2x8GB) DDR5 5600 PRC
- RAM32GB (1x32GB) DDR5 5600
- RAM32GB (2x16GB) DDR5 5600
- RAM32GB (1x32GB) DDR5 5600 PRC
- RAM32GB (2x16GB) DDR5 5600 PRC
- RAM64GB (2x32GB) DDR5 5600

**NOTE:** Memory speed 5600 MT/s can be achieved via two SODIMMs per channel (2DPC) when populated with the same part number.

For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system. Memory modules support data transfer rates up to 2400 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

CAUTION: You must shut down the Retail System and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the Retail System is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.



## Technical Specifications-Storage

## **SOLID STATE STORAGE**

Drive Bays: (2) M.2 PCIe x4 2280/2230 Combo (for storage)

#### PCIe NMVe Solid State Drives (SSD)<sup>1</sup>

- SSD 256GB 2280 PCIe NVMe Value
- 256GB PCIe 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive
- SSD 512GB 2280 PCIe NVMe Value
- SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell
- SSD 1TB 2280 PCIe NVMe Value
- SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell
- SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell
- 4TB PCIe-4x4 2280 NVMe Three Layer Cell double-sided M.2 Solid State Drive

#### Storage accelerator

NVMe RAID 1

#### **Notes:**

1. Storage DriveLock does not work with Self-Encrypting or Optane based storage

**NOTE:** For hard drives and solid state drives, GB= 1 billion bytes. TB= 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### SSD 256G2280 PCIe NVMe Value

Capacity256GBInterfacePCIe NVMeForm FactorM.2Height2.38mmWidth22mmLength80mmWeight<10q</th>

Maximum Sequential Read2000 MB/s ±20%Maximum Sequential Write900 MB/s ±20%Logical Blocks500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### 256GB PCIe 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive

Capacity 256GB
Interface PCIe NVMe
Form Factor M.2
Height 2.38mm
Width 22mm



## **Technical Specifications-Storage**

Length 80mm Weight <10g

Maximum Sequential Read2000 MB/s ±20%Maximum Sequential Write900 MB/s ±20%Logical Blocks500,118,192

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### 512 GB M.2 2280 PCIe NVMe Three Layer Cell Value SSD

#### SSD 512 GB 2280 PCIe NVMe Value

Capacity512GBInterfacePCIe NVMeForm FactorM.2Height2.38mmWidth22mmLength80mmWeight<10g</th>

Maximum Sequential Read2200 MB/s ±20%Maximum Sequential Write1000 MB/s ±20%Logical Blocks1,000,215,215

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity 512GB
Interface PCIe NVMe
Form Factor M.2

Height2.38mmWidth22mmLength80mmWeight<10g</th>

Maximum Sequential Read $6400 \text{ MB/s} \pm 20\%$ Maximum Sequential Write $3500 \text{ MB/s} \pm 20\%$ Logical Blocks1,000,215,215

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]



## QuickSpecs

## Technical Specifications-Storage

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### SSD 1TB 2280 PCIe NVMe Value

Capacity 1TB

Interface PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read2200 MB/s ±20%Maximum Sequential Write1600 MB/s ±20%Logical Blocks2,000,409,264

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity 1TB

Interface PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write5000 MB/s ±20%Logical Blocks2,000,409,264

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

Features APST: ASPM L1.2; NVME spec 1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity 2TB



## QuickSpecs

Weight

## **Technical Specifications-Storage**

InterfacePCIe NVMeForm FactorM.2Height2.38mmWidth22mmLength80mm

Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write5000 MB/s ±20%Logical Blocks4,000,797,360

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

<10a

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### 4TB PCIe-4x4 2280 NVMe Three Layer Cell double-sided M.2 Solid State Drive

Capacity 4TB

**Interface** PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write5000 MB/s ±20%Logical Blocks8,001,594,720

**Operating Temperature** 0° to 70°C(32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### 4TB 2280 PCIe-3x4 NVMe TLC Solid State Drive

Unformat ted Capacit y 4TB

Interface PCIe Gen 3

Form Factor M.2



## QuickSpecs

## **Technical Specifications-Storage**

Height2.38mmWidth22mmLengt h80mmWeight<10g</th>

Maximum Sequential ReadUp to 6600MB/sMaximum Sequent ial WriteUp to 5200MB/sLogical Blocks2,000,409,264

**Operat ing Temperature** 0° to 70°C(32° to 158°F) [ambient temp]

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.



## Technical Specifications – Networking and Communications

## **Networking/Communications**

#### Ethernet (RJ-45)

- Intel®I219-LMGigabit Network Connection LOM(standard)
- Realtek RTL8153CH

### Wireless

- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro®;\*
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, non-vPro® \*\*
- Intel WI-FI 6E AX211 WI-FI 6E and Bluetooth® 5.3 wireless card, non-vPro®\*\*\*

#### **Notes:**

#### **NIC Fundamentals:**

By default, the HP BIOS set the HUB WOLsetting to disabled state, which will not allow wake signal from the USB bus to initiate a wake event. On Engage One Plus, the Embedded Lan Controller is enabled by default and is what HP recommend using as the primary nic for WOLcapability as seen in the BIOS F10 menu If customer has a reason to use the HUB NICand wants to wake the system from that NIC. They must enable wake events for the HUB to get the functionality.

\*Wireless access point and Internet service required and not included. Availability of public wireless access points limited. The specifications for the 802.11ax WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the PCto communicate with 802.11ax WLAN devices. Wi-Fi 6 requires a

The specifications for the 802.11ax WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the PCto communicate with 802.11ax WLAN devices. Wi-Fi 6 requires a wireless router, sold separately, that supports 802.11ax (Wi-Fi 6). Only available in countries where 802.11ax is supported.

\*\* Wi-Fi 6 is backwards compatible with prior 802.11 specs.

You require a wireless access point and internet service. Limited public wireless access points are available. The specifications for the 802.11 WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it might affect the ability of the notebook to communicate with other 802.11 WLAN devices.

Intel® i219LM 10/100/1000 Integrated NIC	
Connector	RJ-45
System Interface	PCI (Intel proprietary) + SMBus
Data rates supported	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet)
Performance	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling(Hash Mode Only) Jumbo Frame 9K



Power consumption	Cable Disconnetion: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
Management Interface	Auto MDI/MDIX Crossover cable detection
IT Manageability	Wake-on-LAN from modem standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
Security & Manageability	Intel®vPro® support with appropriate Intel®chipset components
Intol Wi Ei 6 AV201 + PTE /	802.11ax 2x2, vPro, supporting gigabit file transfer speeds)non-vPro
Wireless LAN Standards	EEE 802.11a
	IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11d IEEE 802.11t IEEE 802.11h IEEE 802.11h IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v
Interoperability	Features Wi-Fi 6 technology
Frequency Band	802.11b/g/n/ax • 2.402 – 2.482 GHz  802.11 <sup>a</sup> /n/ac/ax • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)



Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM	
Security <sup>3</sup>	<ul> <li>IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> </ul>	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power <sup>2</sup>	<ul> <li>802.11b:+18.5dBm minimum</li> <li>802.11g:+17.5dBm minimum</li> <li>802.11<sup>a</sup>:+18.5dBm minimum</li> <li>802.11n HT20(2.4GHz):+15.5dBm minimum</li> <li>802.11n HT40(2.4GHz):+14.5dBm minimum</li> <li>802.11n HT20(5GHz):+15.5dBm minimum</li> <li>802.11n HT40(5GHz):+14.5dBm minimum</li> <li>802.11ac VHT80(5GHz):+11.5dBm minimum</li> </ul>	
	802.11ac VHT160(5GHz): +11.5dBm minimum	
Power Consumption	<ul> <li>Transmit mode: 2.0 W</li> <li>Receive mode: 1.6 W</li> <li>Idle mode (PSP) 180 mW (WLAN Associated)</li> <li>Idle mode: 50 mW (WLAN unassociated)</li> <li>Connected Standby: 10mW</li> <li>Radio disabled: 8 mW</li> </ul>	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensitivity <sup>3</sup>	•802.11b, 1Mbps: -93.5dBm 31áximum  •802.11b, 11Mbps: -84dBm 31áximum  • 802.11a/g, 6Mbps: -86dBm maximum  • 802.11a/g, 54Mbps: -72dBm maximum  • 802.11n, MCS07: -67dBm maximum  • 802.11n, MCS15: -64dBm maximum  • 802.11ac, MCS0: -84dBm maximum  • 802.11ac, MCS0: -59dBm maximum  •802.11ax, MCS11(HT40): -59dBm maximum  •802.11ax, MCS11(VHT160): -58.5dBm maximum	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface	
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230 : 2.8g 2. Type 126: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating 14° to 158° F (–10° to 70° C) Non-operating –40° to 176° F (–40° to 80° C)	



Humidity	Operating 10% to 90% (non-condensing)	
	Non-operating 5% to 95% (non-condensing)	
Altitude	Operating	
	Non-operating 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	
	oth® 4.0/4.1/4.2/5.0/5.1 Wireless Technology	
	14 0/4 4/4 3/5 0/5 4 C I'	
Bluetooth® Specification	4.0/4.1/4.2/5.0/5.1 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps	
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps	
	Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels.	
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth® component shall operate as a Class II Bluetooth®device with a maximum transmit power of +9.5 dBm for BR and EDR.	
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW	
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth® Software	
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Bluetooth Profiles Supported	BT4.1-ESR 5/ 6/ 7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging &Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/ Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAXProfile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)	



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Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping
	LE Dual Mode
	LE Link Layer
	LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train
	Nudging & Interlaced Scan
	BT4.2 ESR08 Compliance
	LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy
	LE Privacy 1.2 –Extended Scanner Filter Policies
	LE Data Packet Length Extension FAX Profile (FAX)
	Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)
	Auvanceu Audio Distribution Pronte (AZDP)
Realt ek RTL8822CE 802.11ac	
Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
	IEEE 802.11d
	IEEE 802.11e
	IEEE 802.11h
	IEEE 802.11i
	IEEE 802.11k
	IEEE 802.11r
1.1	IEEE 802.11v
Interoperability	Wi-Fi®certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz
	802.11ª/n/ac
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	• 5.825 – 5.850 GHz
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
BB - 1 1 - 1 - 1 - 1	• 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, & 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security3	IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/ b/ g mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication     WDA NUBAR ROW NUBAR ROW THERE and AFF
	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	• IEEE 802.11i
N	• WAPI
Network Architecture Models	Ad-hoc (Peer to Peer)



	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power2	802.11b : +18.5dBm minimum
output i ower z	802.11g: +17.5dBm minimum
	802.11 <sup>a</sup> : +18.5dBm minimum
	802.11n HT20(2.4GHz): +15.5dBm minimum
	802.11n HT40(2.4GHz): +14.5dBm minimum
	802.11n HT20(5GHz): +15.5dBm minimum
	<ul> <li>802.11n HT40(5GHz): +14.5dBm minimum</li> </ul>
	<ul> <li>802.11ac VHT80(5GHz): +11.5dBm 35áximum</li> </ul>
	<ul> <li>802.11ac VHT160(5GHz): +11.5dBm minimum</li> </ul>
Intel Wi-Fi 6 AX201 + BT5 (802	.11ax 2x2, non-vPro, supporting gigabit file transfer speeds) non-vPro
Wireless LAN Standards	IEEE802.11a
	IEEE802.11b
	IEEE802.11g
	IEEE802.11n
	IEEE802.11ac
	IEEE802.11ax
	IEEE802.11d
	IEEE802.11e
	IEEE802.11h
	IEEE802.11i
	IEEE802.11k
	IEEE802.11r
	IEEE802.11v
Interoperability	Features Wi-Fi 6 technology
Frequency Band	802.11b/g/n/ax
	• 2.402 – 2.482 GHz
	802.11ª/n/ ac/ ax
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	5.825 – 5.850 GHz
Data Rates	• 802.11b:1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n:MCS0 ~MCS15, (20MHz, and 40MHz)
	<ul> <li>802.11ac:MCS0 ~MCS9, (1SS,and 2SS)(20MHz, 40MHz, ,80MHz &amp;160MHz)</li> </ul>
	802.11ax:MCS0 ~ MCS11,(1SSand 2SS)(20MHz,40MHz,,80MHz&160MHz)
Modulation	Direct Sequence Spread Spectrum
	OFDM,BPSK,QPSK,CCK,16-QAM,64-QAM,256-QAM,1024QAM
Security3	<ul> <li>IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only</li> </ul>
	AES-CCMP:128 bit in hardware
	802.1x authentication
	<ul> <li>WPA,WPA2: 802.1x. WPA-PSK,WPA2-PSK,TKIP,and AES.</li> </ul>
	WPA2certification
	• IEEE802.11i
	• WAPI
Network Architecture Models	Ad-hoc (Peer to Peer)
	Infrastructure (Access Point Required)
Roaming	IEEE802.11 compliant roaming between access points



Output Power2	• 802.11b :+18.5dBm minimum	
vulpul rvwei 2	• 802.110:+18.5dBm minimum  • 802.11g:+17.5dBm minimum	
	• 802.11 <sup>a</sup> :+18.5dBm minimum	
	• 802.11n HT20(2.4GHz):+15.5dBm minimum	
	• 802.11n HT40(2.4GHz):+14.5dBm minimum	
	• 802.11n HT20(5GHz):+15.5dBm minimum	
	• 802.11n HT40(5GHz):+14.5dBm minimum	
	802.11ac VHT80(5GHz): +11.5dBm minimum	
	<ul> <li>802.11ac VHT160(5GHz): +11.5dBm minimum</li> </ul>	
	<ul> <li>802.11ax HT40(2.4GHz):+10dBm minimum</li> </ul>	
	802.11ax VHT160(5GHz): +10dBm minimum	
Power Consumpt ion	Transmit mode 2.0 W	
	Receive mode 1.6 W	
	Idle mode (PSP)180 mW(WLANAssociated)	
	Idle mode 50 mW(WLANunassociated)	
	Connected Standby 10mW	
	Radio disabled 8 mW	
Power Management	ACPland PCIExpress compliant power management	
	802.11 compliant power saving mode	
Receiver Sensitivity3	•802.11b, 1Mbps:-93.5dBm 33áximum	
	•802.11b, 11Mbps: -84dBm 33áximum	
	802.11a/g, 6Mbps:-86dBm maximum	
	802.11a/g, 54Mbps : -72dBm maximum	
	• 802.11n, MCS07:-67dBm maximum	
	802.11n,MCS15 :-64dBm maximum	
	802.11ac, MCS0 :-84dBm maximum	
	802.11ac, MCS9 : -59dBm maximum	
	•802.11ax, MCS11(HT40):-59dBm maximum	
	• 802.11ax, MCS11(VHT160):-58.5dBm maximum	
Ant enna type	High efficiency antenna with spatial diversity, mounted in the display enclosure	
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN	
	MIMOcommunications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard with CNViInterface	
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm	
	2. Type 1216:1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230:2.8g	
	2. Type 126:1.3g	
Operating Voltage	3.3v +/- 9%	
operating foliage	3.50 7 370	
Temperature	Operating 14° to 158° F(–10° to 70° C)	
- F	Non-operating -40° to 176° F(-40° to 80° C)	
Humidit y	Operating 10% to 90% (non-condensing)	
<i>y</i>	Non-operating 5% to 95% (non-condensing)	
	Non operating 570 to 5570 (non condensing)	
Altitude	Operating 0 to 10,000 ft (3,048 m)	



LEDActivity	LEDAmber – Radio OFF;LEDOff – Radio ON
HP Integrated Module with Bluetooth	<sup>®</sup> 4.0/ 4.1/ 4.2/ 5.0/ 5.1 Wireless Technology
Bluet ooth® Specification	4.0/4.1/4.2/5.0/5.1 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy:0~79 (1 MHz/CH)BLE:0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
- aca macco ama im ougriput	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
	Legacy: Synchronous Connect ion Oriented links up to 3, 64 kbps, voice channels.
Transmit Power	The Bluetooth® component shall operate as a Class II Bluetooth® device with a maximum transmit power of +9.5 dBm for BRand EDR.
B	·
Power Consumption	Peak (Tx) 330 mWPeak (Rx) 230 mW Selective Suspend 17 mW
Bluet ooth® Software Supported Link Topology	Microsoft Windows Bluetoothâ Software
Power Management	Microsoft Windows ACPI, and USBBus Support
Cert ificat ions	FCC(47 CFR)Part 15C, Section 15.247 &15.249 ETS
	300 328, ETS 300 826
Division and Division Community	Low Voltage Directive IEC60950 UL, CSA, and CEMark
Bluetooth Profiles Supported	BT4.1-ESR5/6/7 Compliance LELink Layer Ping
	LEDual Mode LELink Layer LELow Duty Cycle Directed Advertising
	LEL2CAPConnection Oriented Channels Train Nudging &Interlaced Scan BT4.2
	ESR08 Compliance
	LESecure Connection- Basic/Full LEPrivacy 1.2 –Link Layer Privacy
	LEPrivacy 1.2 – Extended Scanner Filter Policies LEData Packet Length Extension
	FAXProfile (FAX)
	Basic Imaging Profile (BIP)2 Headset Profile (HSP)
	Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)
Realtek RTL8822CE802.11ac 2x2	
Wireless LAN Standards	IEEE802.11a
	IEEE802.11b
	IEEE 802.11g
	IEEE802.11n
	IEEE802.11ac
	IEEE802.11d
	IEEE802.11e
	IEEE 802.11h
	IEEE 802.11i
	IEEE802.11k
	IEEE802.11r
	IEEE802.11v
Interoperability	Wi-Fi®certified
Frequency Band	802.11b/g/ n
	• 2.402 – 2.482 GHz
	802.11 <sup>a</sup> /n/ ac
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz



## Technical Specifications – Networking and Communications

	• 5.47 – 5.725 GHz
	5.825 – 5.850 GHz
	3.823 – 3.830 GHZ
Data Rates	• 802.11b:1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n:MCS0 ~MCS15, (20MHz, and 40MHz)
	802.11ac:MCS0~MCS9,(1SS,and 2SS)(20MHz,40MHz&80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK,QPSK,CCK,16-QAM, 64-QAM, 256-QAM
Security3	<ul> <li>IEEEand WiFicompliant 64 / 128 bit WEPencryption for a / b / g mode only</li> </ul>
	AES-CCMP:128 bit in hardware
	802.1x authentication
	WPA,WPA2: 802.1x. WPA-PSK,WPA2-PSK,TKIP,and AES.
	WPA2certification
	• IEEE802.11i
	• WAPI
Network Architecture Models	Ad-hoc (Peer to Peer)
	Infrastructure (Access Point Required)
Roaming	IEEE802.11 compliant roaming between access points
Output Power2	• 802.11b : +18.5dBm minimum
•	• 802.11g:+17.5dBm minimum
	• 802.11 <sup>a</sup> :+18.5dBm minimum
	• 802.11n HT20(2.4GHz):+15.5dBm minimum
	• 802.11n HT40(2.4GHz):+14.5dBm minimum
	• 802.11n HT20(5GHz):+15.5dBm minimum
	• 802.11n HT40(5GHz):+14.5dBm minimum
	802.11ac VHT80(5GHz): +11.5dBm 35áximum
	802.11ac VHT160(5GHz): +11.5dBm minimum
Power Consumpt ion	Transmit mode :2.0 W
rower consumption	Receive mode :1.6 W
	<ul> <li>Idle mode (PSP)180 mW(WLANAssociated)</li> <li>Idle mode :50 mW(WLANunassociated)</li> </ul>
	Connected Standby/Modern Standby: 10mW
	Radio disabled: 8 mW
Power Management	ACPland PCIExpress compliant power management
rower management	802.11 compliant power saving mode
	002.11 Compliant power saving mode
Receiver Sensitivity3	802.11b, 1Mbps : -93.5dBm 35áximum 802.11b, 11Mbps : -84dBm 35áximum 802.11²/ g,
•	6Mbps:-86dBm 35áximum 802.11ª/ g, 54Mbps:-72dBm 35áximum 802.11n, MCS07:-67dBm
	35áximum 802.11n, MCS15:-64dBm 35áximum 802.11ac, MCS0:-84dBm 35áximum
	• 802.11ac, MCS9 :-59dBm maximum
Ant enna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
- <del> </del>	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLANMIMO
	communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNViInterface
Dimensions	3. Type 2230 : 2.3 x 22.0 x 30.0 mm
	4. Type 1216:1.67 x12.0 x16.0 mm
	l .



## Technical Specifications – Networking and Communications

Weight	3. Type 2230 : 2.8g			
	4. Type 126:1.3g			
Operating Voltage	3.3v +/- 9%			
Temperature	Operating 14° to 158° F(-10° to 70° C) Non-operating -40° to 176° F(-40° to 80° C)			
Humidit y	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)		
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)		
LEDActivity	LEDAmber – Radio	OFF;LEDOff – Radio ON		
HP Integrated Module with Bluetooth	<sup>®</sup> 4.0/ 4.1/ 4.2/ 5.0	Wireless Technology		
Bluet ooth® Specification	4.0/4.1/4.2/5.0 C	ompliant		
Frequency Band	2402 to 2480 MH			
Number of Available Channels	Legacy:0~79(1 MH	Hz/CH)BLE:0~39 (2 MHz/CH)		
Data Rates and Throughput	Legacy : 3 Mbps d	ata rate; throughput up to 2.17 Mbps		
	BLE: 1 Mbps data	rate; throughput up to 0.2 Mbps		
		ious Connect ion Oriented links up to 3, 64 kbps, voice channels		
	Legacy: Asynchronous Connection Less links 2178.1 kbps/ 177.1 kbps asymmetric (3-DH5)			
	or 864 kbps symmetric (3-EV5)			
Transmit Power	The Bluetooth® component shall operate as a Class IIBluetooth® device with a maximum transmit power of +4 dBm for BRand EDR.			
Power Consumption	Peak (Tx) 330 mWPeak (Rx) 230 mW Selective Suspend 17 mW			
Bluet ooth® Software Supported Link Topology	Microsoft Windows Bluetooth® Software			
Power Management	Microsoft Windows ACPI, and USBBus Support			
Cert ificat ions	FCC(47 CFR)Part 15C,Section 15.247 &15.249			
Power Management Certifications	ETS300328,ETS3	00 826		
	Low Voltage Directive	ve IEC950 UL,CSA,and CEMark		
Bluet ooth Profiles Supported	BT4.1-ESR5/6/7 Cd	ompliance LELink Layer Ping		
	LEDual Mode			
	LELink Layer			
	LELow Duty Cycle Directed Advertising			
	LEL2CAPConnection Oriented Channels Train			
	Nudging &Interlaced Scan BT4.2 ESR08 Compliance			
	LESecure Connection- Basic/Full LEPrivacy 1.2 –Link			
	Layer Privacy LE Privacy 1.2 –Extended Scanner			
	Filter Policies			
	LEData Packet Length Extension FAXProfile (FAX)			
	Basic Imaging Profile (BIP)2 Headset Profile (HSP)			
	Hands Free Profile			
	Advanced Audio Di	stribution Profile (A2DP)		

Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro® and NonvPro Module



## Technical Specifications – Networking and Communications

The Intel® Wi-Fi 7 BE200 adapter is designed to support the upcoming IEEE 802.11be standard – Wi-Fi 71 technology and the Wi-Fi Alliance Wi-Fi 7 certification. Aligned with the upcoming IEEE 802.11be standard, the Intel® Wi-Fi 7 BE200 module supports these key features: 4096QAM and 320MHz channels resulting in 2.4X higher peak data rates4, Multi-link Operation (MLO - eMLSR), Multi-resource unit (Multi-RU) and Puncturing.

Intel® Wi-Fi 7 BE200 Mod	dule Technical Specificati	ons
--------------------------	----------------------------	-----

GENERAL	
Dimensions (H x W x D)	M.2 2230: 22mm x 30mm x 2.42mm (max) M.2 1216: 12mm x 16mm x 1.7 (+-0.1) mm
Weight	M.2 2230: 3.07+/-0.15g M.2 1216: 0.75+/-0.04g
Radio ON/OFF Control	Supported
Connector Interface	M.2: PCIe*, USB
Operating Temperature (Ambient)	0°C to +50°C
Humidity Non-Operating	50% to 90% RH non-condensing (at temperatures of 25°C to 35°C)
Operating Systems	Microsoft* Windows 11*, Microsoft* Windows 10*, Linux*
Wi-Fi Alliance <sup>6</sup>	Wi-Fi 7 Technology support, Wi-Fi CERTIFIED* 6 with Wi-Fi 6E, Wi-Fi CERTIFIED* a/b/g/n/ac, WMM*, WMM*-Power Save, WPA3*, PMF*, Wi-Fi Direct*, Wi-Fi Agile Multiband*, Wi-Fi Location R2 HW readiness <sup>7</sup>
IEEE WLAN Standard	IEEE 802.11-2020 and select amendments (selected feature coverage) IEEE 802.11a, b, d, e, g, h, i, k, n, r, u, v, w, ac, ax, be; Fine Timing Measurement based on 802.11-2016, 802.11az HW readiness
Bluetooth®	Bluetooth® 5.4 (Ant. 1)
SECURITY FEATURES	
Security Methods	WPA3* personal and enterprise including WPA2* transition mode
Authentication Protocols	802.1X EAP-TLS, EAP-TTLS/MSCHAPv2, PEAPv0 -MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA')
Encryption	128-bit AES-CCMP, 256-bit AES-GCMP
COMPLIANCE	
Regulatory	For a list of country approvals, please contact your local Intel representatives.
US Government	FIPS <sup>9</sup> 140-3
Product Safety	UL, C-UL, CB (62368-1)

Product Name	Model Number	Version
Intel® Wi-Fi 7 BE200	BE200NGW BE200D2W	Wi-Fi 7, 2x2, Bluetooth® 5.4, M.2 2230 Wi-Fi 7, 2x2, Bluetooth® 5.4, M.2 1216

<sup>&</sup>lt;sup>1</sup> Wi-Fi 7 (802.11be) WFA certification is not yet available. Intel® Wi-Fi 7 BE200 module will be delivered as a pre-certified solution.

<sup>802.11</sup> wireless standard specifications, and require the use of similarly configured 802.11be wireless network routers.



<sup>&</sup>lt;sup>2</sup> Name and features might change based on Bluetooth SIG direction

<sup>&</sup>lt;sup>3</sup> "5 Gbps Wi-Fi 7 2x2 client speed" - is based on the current draft of the 802.11be specification, which specifies the theoretical maximum data rate for a 2x2 device that supports 320 MHz channels in the 6GHz band, with a 4096 QAM modulation is 5.76 Gbps. Based on an industry-standard efficiency assumption, the resulting estimated maximum over-the-air 2x2 client UDP throughput speed would be 5 Gbps

<sup>4</sup> "2.4X higher peak data rates" Intel® Wi-Fi, 7 BE200 claims, are based on the comparison of the expected maximum theoretical data rates for

<sup>&</sup>quot;2.4X higher peak data rates" Intel® Wi-Fi, 7 BE200 claims, are based on the comparison of the expected maximum theoretical data rates for similarly configured single radio Wi-Fi 7 (802.11be) and standard Wi-Fi 6 (802.11ax) Wi-Fi solutions as documented in current IEEE 802.11be spec and IEEE

#### Technical Specifications – Networking and Communications

<sup>5</sup> Intel® vPro® Technology is sophisticated and requires setup and activation. Availability of features and results will depend upon the setup and configuration of your hardware, software, and IT environment. To learn more, visit: http://www.intel.com/technology/vpro.

<sup>6</sup> Support of Wi-Fi Alliance certifications is OS-dependent.

<sup>7</sup> IEEE 802.11az hardware readiness per expected Wi-Fi Location R2 feature support and based on draft 2.1 of the IEEE802.11az amendment and is subject to change.

<sup>8</sup> Some security solutions may not be supported by your device operating system and/or by your device manufacturer or may require additional hardware (e.g., UICC – SIM card). Check with your device manufacturer for details on availability.

<sup>9</sup> Pre-certified

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Tests document the performance of components on a particular test, in specific systems. Differences in hardware, software, or configuration will affect actual performance. Consult other sources of information to evaluate performance as you consider your purchase. For more complete information about performance and benchmark results, visit <a href="https://www.intel.com/benchmarks">www.intel.com/benchmarks</a>.

Estimated results were obtained prior to implementation of recent software patches and firmware updates intended to address exploits referred to as "Spectre" and "Meltdown". Implementation of these updates may make these results inapplicable to your device or system.

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#### **NFC NXP NPC300**

Dimensions (L x W

17 x 10 x 2.0 mm

x H)

Chipset NPC300 System interface I2C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

**Reader (PCD-VCD)** ISO/IEC 14443 A Mode(1) ISO/IEC 14443 B

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K

MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC- ISO/IEC 14443 A

**VICC) Mode(1)** ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

**NFC Modes Supported** Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps



## Technical Specifications – Networking and Communications

Operating

temperature 0°C to 70°C

Storage temperature -20°C to 125°C

Humidity 10-90% operating 5-95% non-operating

**Supply Operating** 

**voltage** 4.35 to 5.25 Volts **I/O Voltage** 1.8V or 3.3V

**Power Consumption** Booster enable, VBAT= 3.3V,

VCC\_BOOST = 5V) Polling 7.3 mA

Mode Power Detected Test Total 28

Mode Power
Consumption,
Tag Type 1

Detected Test
Total 283.8 mA
Net Module 236.8 mA
Typical

Detected Test
Total 288.8 mA
Typical

Detected TestTotal 288.8 mATag Type 2Net Module 241.8 mADetected TestTotal 287.7 mATag Type 3Net Module 240.7 mADetected TestTotal 282.3 mATag Type 4Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

#### Technical Specifications - Audio/Multimedia

## **High-Definition Audio**

#### Engage One System Audio (Realtek ALC3247-CG)

**Type** Integrated

**HD Stereo Codec** High-Definition Audio codec **Internal Speaker Amplifier** 4-channel DAC, 4-channel ADC,

and an integrated stereo Class-D Speaker Amplifier

Sampling Sampling frequency=48kHz
Analog Audio Yes, Audio Jack support CTIA type
# of Channels on line-out Stereo (Left & Right channels)

Internal speaker Yes

Microphone Yes, stereo digital microphone input with Realtek proprietary Acoustic Echo

Cancellation (AEC), Beam Forming (BF), and Noise Suppression (NS) technology, significantly

improving voice quality for PC VoIP applications

Maximum Power Output 2W per channel at 5V power supply

**Headphone** yes

## Technical Specifications – Integrated Camera

#### 1.2 Basic Specification

Camera	5MP+IR camera
Sensor	RGB: 1/4.7" 5M CMOS (0V05C) IR: 1/10.5" 400x400 CMOS (0V6211)
Effective Pixel	RGB: 2880x1800 IR: 400x400
Output Image Size	RGB: Up to 2880x1800 IR: Up to 400x400
Output Format	YUY2, MJPEG
Frame Rate	RGB : 30fps @ MJPG 5M IR : 30fps @Y8 400x400
Lens Structure	RGB: F/2.0, 4P IR: F/2.0, 3P
Outside Dimension	96±0.2 x 5±0.1 x 3.38±0.15 (unit: mm) (Including Lens + PCB + adhesive tape)
PCB thickness	0.3±0.08mm
Interface	USB 2.0
LED Color	White



## Technical Specifications – Integrated Camera

<b>RGB</b> :	HP	5MP	Camera
--------------	----	-----	--------

#### IR: HP IR Camera

#### **Features**

- > Automatic image control
- ✓ Automatic / Manually Exposure Control
- ✓ Automatic / Manually White Balance Control
- ✓ Automatic Gain Control
- √ Face AE
- ✓ Temporal Noise Reduction
- ✓ High Dynamic Range
- ✓ Human Presence Detection
- ✓ Low Light Compensation
- ✓ Power Line Flicker Compensation (default@ 60Hz)
- ✓ Gain
- Resolution Support for Still/Motion Image

- Image Quality Control (Adjust Manually)
- ✓ Brightness
- ✓ Contrast
- ✓ Hue
- ✓ Saturation
- √ Sharpness
- ✓ Gamma
- ✓ Backlight Compensation



#### Technical Specifications – Power

#### **POWER**

**Power Supply** 280Watt Smart PFC Standard Barrel 7.4mm Straight 1.8m C14 SR-S; 89% efficiency (advance hub)

230Watt Smart PFC Slim Barrel 7.4mm Right Angle; 89% efficiency (Column hub & VESA hub)

150 Watt Smart PFC Slim Barrel 7.4mm Straight, 89% efficiency (hubless)

Operating Voltage Range90V~265VACRated Voltage Range100V~240ACRated Line Frequency50~60HZOperating Line Frequency47~63HZ

Range

**Rated Input Current** <2.4A RMS/280W, <3.52A/230W

Power Supply Fan N/A

**ENERGY STAR® Compliant** ENERGY STAR® certified configurations available and EPEAT® registered \*

Power Cord Length 1.8m

NOTE: Power supply meets ENERGY STAR® compliance in conjunction with a select range of

processors and modules.

\*Energy Star in under testing & in process of certification at the time this document is written

#### **WEIGHTS & DIMENSIONS**

NOTE: Weight and dimensions below do not include MSR, Biometric Reader, Webcam, or CFD.





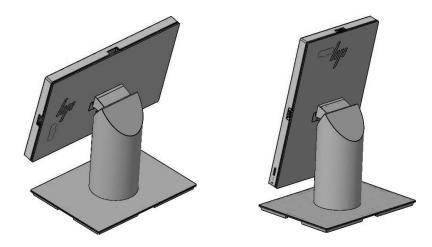
Head Unit-15.6"			
Metric	US		
241.0	9.5		
397.6	15.7		
26.4	1.0		
2.5	152.04		
391.6	15.4		
241.0	9.5		
	241.0 397.6 26.4		



## Technical Specifications – Power

Depth [mm/in]	26.4	1.0
Volume (Litters/cubic inches)	2.5	152.04
Head Unit-15.6" Weight (Landscape)		
[kg/lb.]	3.37	7.4
Head Unit-15.6" Weight (Portrait)		
[kg/lb.]	3.37	7.4



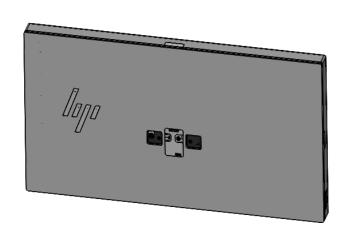


Head Unit-15.6"		
	Metric	US
Landscape dimensions (when working angle is 12 degree)		
Height [mm/in]	365.8	14.4
Width [mm/in]	391.6	15.4
Depth [mm/in]	220.0	8.7
Volume (Litres/cubic inches)	31.5	1923.13
Portrait dimensions (when working angle is 12 degree)		
Height [mm/in]	439.4	17.3
Width [mm/in]	305.0	12.0
Depth [mm/in]	220.0	8.7
Volume (Litters/cubic inches)	29.5	1799.21
Head Unit-15.6" Weight (Landscape) + Gordo Stand		
[kg/lb.]	6.70	14.8
Head Unit-15.6" Weight (Portrait)+ Gordo Stand		
[kg/lb.]	6.70	14.8





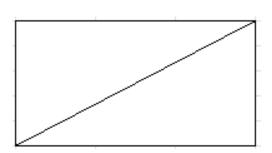
Head Unit-15.6"		
	Metric	US
Landscape dimensions (when working angle is 40~140 degree)		
Height [mm/in]	346.3	13.6
Width [mm/in]	391.6	15.4
Depth [mm/in]	220.0	8.7
Volume (Litters/cubic inches)	29.8	1820.61
Portrait dimensions (when working angle is 40~140 degree)		
Height [mm/in]	404.0	15.9
Width [mm/in]	305.0	12.0
Depth [mm/in]	271.8	10.7
Volume (Litters/cubic inches)	33.5	2043.76
Head Unit-15.6" Weight (Landscape)+ Gordo Stand		
[kg/lb.]	6.70	14.8
Head Unit-15.6" Weight (Portrait)+ Gordo Stand		
[kg/lb.]	6.70	14.8





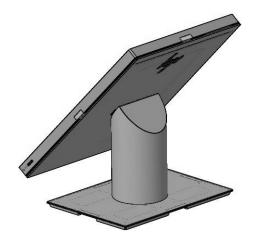
Head Unit-19.5"		
	Metric	US
Head Unit-19.5" Dimensions (Landscape)		
Height [mm/in]	292.6	11.5
Width [mm/in]	494.8	19.2
Depth [mm/in]	29.4	1.2
Volume (Litres/cubic inches)	4.2	256.60
Head Unit-19.5" Dimensions (Portrait)		
Height [mm/in]	488.8	19.2
Width [mm/in]	292.6	11.5
Depth [mm/in]	29.4	1.2
Volume (Litres/cubic inches)	4.2	256.60
Head Unit-19.5" Weight (Landscape)		
[kg/lb.]	5.70	12.6
Head Unit-19.5" Weight (Portrait)		
[kg/lb]	5.70	12.6



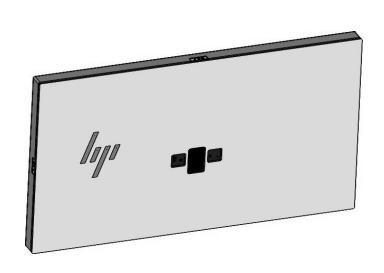


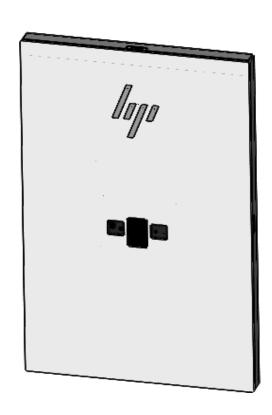
Head Unit-19.5"		
	Metric	US
Landscape dimensions (when working angle is 12 degree)		
Height [mm/in]	391.6	15.4
Width [mm/in]	488.8	19.2
Depth [mm/in]	220.0	8.7
Volume (Litres/cubic inches)	42.1	2569.78
Portrait 19.5" does not support 12 degrees		
Height [mm/in]		
Width [mm/in]		
Depth [mm/in]		
Volume (Litres/cubic inches)		
Head Unit-19.5" Weight (Landscape)		
[kg/lb.]	8.80	19.4
Head Unit-19.5" Weight (Portrait)		
[kg/lb]		





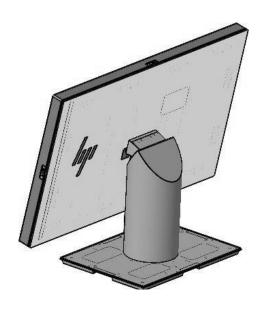
Head Unit-19.5"		
	Metric	US
Landscape dimensions (when working angle is 40~140 degree)		
Height [mm/in]	368.0	14.5
Width [mm/in]	488.8	19.2
Depth [mm/in]	239.5	9.4
Volume (Litres/cubic inches)	43.1	2628.96
portrait dimensions (when working angle is 40~140 degree)		
Height [mm/in]	443.2	17.4
Width [mm/in]	305.0	12.0
Depth [mm/in]	336.5	13.2
Volume (Litres/cubic inches)	45.5	2775.77
Head Unit-19.5" Weight (Landscape)+Gordo Stand		
[kg/lb.]	8.80	19.4
Head Unit-19.5" Weight (Portrait)+Gordo Stand		
[kg/lb]	8.80	19.4

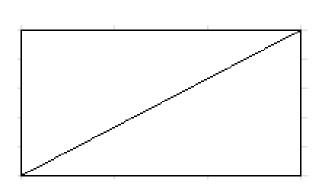




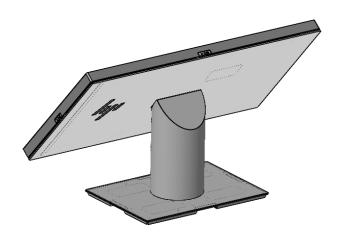
Head Heit 22 Off Disconniscon (Londones a)	Metric	US
Hand Harit 22 Oll Birmanniana (Landanana)		
Head Unit-23.8" Dimensions (Landscape)		
Height [mm/in]	339.9	13.4
Width [mm/in]	570.4	22.5
Depth [mm/in]	29.4	1.2
Volume (Litres/cubic inches)	5.7	347.84
Head Unit-23.8" Dimensions (Portrait)		
Height [mm/in]	570.4	22.5
Width [mm/in]	339.9	13.4
Depth [mm/in]	29.4	1.2
Volume (Litres/cubic inches)	5.7	347.84
Head Unit-23.8" Weight (Landscape)		
[kg/lb.]	10.60	23.4
Head Unit-23.8" Weight (Portrait)		

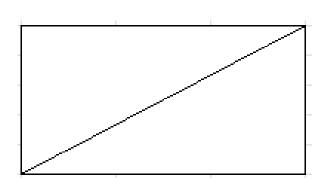
[kg/lb]	10.60	23.4





Head Unit-23.8"		
	Metric	US
Landscape dimensions (when working angle is 12 degree)		
Height [mm/in]	414.7	16.3
Width [mm/in]	570.4	22.5
Depth [mm/in]	220.0	8.7
Volume (Litres/cubic inches)	52.0	3175.67
Portrait 23.8" does not support 12 degrees		
Height [mm/in]		
Width [mm/in]		
Depth [mm/in]		
Volume (Litres/cubic inches)		
Head Unit-19.5" Weight (Landscape)		
[kg/lb.]	10.60	23.4
Head Unit-19.5" Weight (Portrait)		
[kg/lb]		





Head Unit-23.8"		
	Metric	US
Landscape dimensions (when working angle is 40~140 degree)		
Height [mm/in]	386.2	15.2
Width [mm/in]	570.4	22.5
Depth [mm/in]	254.7	10.0
Volume (Litres/cubic inches)	56.1	3423.89
Portrait does not support 40~140 degree		
Height [mm/in]		
Width [mm/in]		
Depth [mm/in]		
Volume (Litres/cubic inches)		
Head Unit-19.5" Weight (Landscape)+ Gordo Stand		
[kg/lb.]	10.60	23.4
Head Unit-19.5" Weight (Portrait)+ Gordo Stand		
[kg/lb]		

**Pro Stand** 





Marketting Name	Pro S	tand	Advanced	Stand
	Metric	US	Metric	US
Stand Dimensions(with Stability Base)				
Height [mm/in]	207.05	8.15	243.3	9.6
Width [mm/in]	305	12	305	12
Depth [mm/in]	220	8.7	220	8.7
Stand Dimensions (without Stability Base)				
Height [mm/in]	195.35	7.69	231.5	9.1
Width [mm/in]	105	4.13	110	4.3
Depth [mm/in]	105	4.13	110	4.3
Stand Weight with Stability Base				
Weight [kg/lb]	2.35	5.2	3.1	6.8
Stand Weight without Stability Base				
Weight [kg/lb]	0.95	2.1	1.7	3.7

Engage One Pro G2 Advanced Fanless hub		
	Metric	US
Hub Dimensions (with Lifted Hub surround)		
Height [mm/in]	220.3	8.7
Width [mm/in]	305.3	12.0
Depth [mm/in]	36.7	1.4
Hub Dimensions (Without Lifted Hub surround)		
Height [mm/in]	100.0	3.9
Width [mm/in]	275.0	10.8
Depth [mm/in]	28.5	1.1
Hub Weight with Lifted Hub surround		
Weight [kg/lb]	1.00	2.2
Hub Weight (without Spring Hub surround) or Possum Hub Only		
Weight [kg/lb]	0.69	1.5

Engage One Pro G2 Advanced Fanless hub		
Metric	US	
220.3	8.7	
305.3	12.0	
36.7	1.4	
100.0	3.9	
275.0	10.8	
28.5	1.1	
1.00	2.2	
0.69	1.5	
	220.3 305.3 36.7 100.0 275.0 28.5	



HP Engage One Pro G2 VESAhub and Hubless USB-A			
	Metric	US	
Dimensions			
Height [mm/in]	150.0	5.9	
Width [mm/in]	125.0	4.9	
Depth [mm/in]	24.4	1.0	
Weight(Without Adapter)			
[kg/lb.]	0.54	1.20	

HP Engage One Pro G2 Slim VESAMount			
	Metric	US	
Dimensions			
Height [mm/in]	120.0	4.7	
Width [mm/in]	120.0	4.7	
Depth [mm/in]	10.5	0.4	
Weight			
[kg/lb.]	0.23	0.51	

Engage Pro G2 Advanced Stand			
	Metric	US	
Stand Dimensions(with Stability Base)			
Height [mm/in]	243.3	9.6	
Width [mm/in]	305.0	12.0	
Depth [mm/in]	220.0	8.7	
Stand Dimensions (without Stability Base)			
Height [mm/in]	231.5	9.1	
Width [mm/in]	110.0	4.3	
Depth [mm/in]	110.0	4.3	
Stand Weight with Stability Base (without wombat)			
Weight [kg/lb]	3.13	6.9	
Stand Weight without Stability Base (without wombat)			

Weight [kg/lb]	1.70	3.7

Engage Pro G2 Stand		
	Metric	US
Stand Dimensions(with Stability Base)		
Height [mm/in]	239.3	9.0
Width [mm/in]	308.0	13.0
Depth [mm/in]	220.0	8.7
Stand Dimensions (without Stability Base)		
Height [mm/in]	239.3	9.0
Width [mm/in]	110.0	4.3
Depth [mm/in]	110.0	4.3
Stand Weight with Stability Base (without wombat)		
Weight [kg/lb]	3.13	6.9
Stand Weight without Stability Base (without wombat)		
Weight [kg/lb]	0.91	2



## Technical Specifications - Miscellaneous Features

#### **System Summary Dimension Mat rix Summary table**

Display Heads Only	Width (Horizontal)	Height (Vertical)	Thickness
15.6 Landscape	397.6	241.0	26.4
19.5 Landscape	494.8	292.6	29.4
23.8 Landscape	576.4	339.9	29.4
15.6 Portrait	241.0	391.6	26.4
19.5 Portrait	292.6	488.8	29.4
23.8 Portrait- Slim VESA only*	339.9	570.4	29.4

## **NOTE:** \*23.8" Portrait can only be support with SLIM VESA mount, not configurable with any Column stand, not configurable with column hub

	Width	Depth	Thickness
Stability Base Only	305.0	220.0	11.7
Stability Base With Advance Hub	305.0	220.0	38.7
Delta Height with Advance hub (Note 1 – Add 27 mm to height dimensions when using with the Advance			
Hub)	305.0	220.0	27.0

10" CFD module			
	Metric	US	
10" CFD Dimensions			
Height [mm/in]	170.2	6.7	
Width [mm/in]	246.2	9.7	
Depth [mm/in]	18.0	0.7	
Weight(Without cable) [kg/lb]	1.00	2.20	

Technical Specifications - Miscellaneous Features

#### MISCELLANEOUS FEATURES

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
- Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

#### **HP Point of Sale Diagnostics UEFI:**

This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support

#### **Serviceability Features:**

- System/Emergency ROM
- Flash ROM
- Flash Recovery with Video Configuration Record Software
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- Clear CMOS Button
- Color coordinated cables and connectors
- Front power switch
- System memory can be upgraded without removing the system board or any internal components

#### Interpreting System Validation Diagnostic Front Panel LEDs and Audible Codes

During the system validation phase that occurs at system startup, the BIOS validates the functionality of the following subsystems and conditions:

- AC adapter
- System board power
- Processor failure
- **BIOS** corruption
- Memory failure
- **Graphics** failure
- System board failure
- **BIOS** authentication failure

If an error is detected, specific patterns of long and short blinks, accompanied by long and short beeps (where applicable) are used to identify the error. These patterns 48esi make up a two part code:

- Major the category of the error
- Minor the specific error within the category



**NOTE:** Single beep/blink codes are not used.

Number of long beeps/blinks	Error category
1	Not used
2	BIOS



#### Technical Specifications - Miscellaneous Features

3	Hardware
4	Thermal
5	System board

Patterns of blink/beep codes are determined by using the following parameters:

- 1 second pause occurs after the last major blink.
- 2 second pause occurs after the last minor blink.
- Beep error code sequences occur for the first 5 iterations of the pattern and then stop.
- Blink error code sequences continue until the computer is unplugged or the power button is pressed.



NOTE: Not all diagnostic lights and audible codes are available on all models.

The red LED blinks to represent the major error category (long blinks). The white LED blinks to represent the minor error category (short blinks). For example, '3.5' indicates 3 long red blinks and 5 short white blinks to communicate the processor is not detected.

Category	Major/minor code	Description
BIOS	2.2	The main area (DXE) of BIOS has become corrupted and there is no recovery binary image available.
	2.3	The embedded controller policy requires the user to enter a key sequence.
	2.4	The embedded controller is checking or recovering the boot block.
Hardware	3.2	The embedded controller has timed out waiting for BIOS to return from memory initialization.
	3.3	The embedded controller has timed out waiting for BIOS to return from graphics initialization.
	3.4	The system board displays a power failure (crowbar).*
	3.5	The processor is not detected.*
	3.6	The processor does not support an enabled feature.
Thermal	4.2	A processor over temperature condition has been detected.*
	4.3	An ambient temperature over temperature condition has been detected.
	4.4	An MXM over temperature condition has been detected.
System board	5.2	The embedded controller cannot find valid firmware.
	5.3	The embedded controller has timed out waiting for the BIOS.
	5.4	The embedded controller has timed out waiting for BIOS to return from system board initialization.
	5.5	The embedded controller rebooted the system after a possible lockup condition had been detected through the use of a System Health Timer, Automated System Recovery Timer, or other mechanism.

<sup>\*</sup> Indicates hardware triggered event; all other events are controlled by the BIOS.

#### TEMPERATURE, HUMIDITY, ALTITUDE

**Temperature Operating**  50° to 104° F (10 to 40° C)



## Technical Specifications - Miscellaneous Features

	Non-operating	-22° to 149° F (-30°to 65° C)
Humidity	Operating	20%-85% relative humidity at max inlet temperature
	Non Operating	20%-85% relative humidity at max inlet temperature
Shock	Operating	40g, six surfaces
	Non Operating	30g, six surfaces
Vibration	Operating	2-g peak acceleration
	Non Operating	3-g peak acceleration
Altitude	Operating	0 to 10,000 ft (3,048 m)
(unpressurized)	Non-operating	0 to 30,000 ft (9,144 m)



#### Technical Specifications - Environmental

#### **ENVIRONMENTAL & INDUSTRY**

#### **Environmental Data**

## Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR® certified configurations available
- EPEAT® Gold with Climate+ registered configurations available. See www.epeat.net for registration status and tier levels by country.

\*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information

#### Sustainable Impact Specifications

- 15% Recycle SGCC steel chassis, 80% Recycled Aluminum in rear plate
- 75% post-consumer recycled plastic in packaging<sup>4</sup>
- Low halogen<sup>1</sup>

115VAC 60Hz

- 25% Ocean-Bound Plastic in speaker enclosure<sup>2</sup>
- 50% Ocean-Bound Plastic in fan enclosure<sup>2</sup>
- 25% ITE-derived closed loop plastic<sup>6</sup>

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Engage One Pro model is based on a typically configured system featuring an SSD, a high efficiency power supply, and a Microsoft Windows® operating system.

SOUNC EURS

#### HP Engage One Pro G2 AiO System Model 15.6"

#### Energy Consumption (in accordance with US ENERGY STAR® test method)

JIAN LESCHIECHOU)	I I JVAC, OUIIZ	ZJUVAC, JUIIZ	IUUVAC, UUIIZ
Normal Operation (Short idle)	10.79W	10.87W	10.63W
Normal Operation (Long idle)	9.53 W	9.53W	9.41W
Sleep	1.77 W	1.76W	1.76W
Off	0.95W	0.96W	0.95W
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	42.89 BTU/hr	44.59 BTU/hr	43.02 BTU/hr
Normal Operation (Long idle)	36.54 BTU/hr	37.39 BTU/hr	36.74 BTU/hr
Sleep	11.15 BTU/hr	11.29 BTU/hr	11.12 BTU/hr
Off	3.92 BTU/hr	3.99 BTU/hr	3.92 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

**NOTE:** Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

#### HP Engage One Pro G2 AiO System Model 19.5"

Energy Consumption (in accordance with US ENERGY

STAR® test method)
115VAC, 60Hz
230VAC, 50Hz
100VAC, 60Hz
Normal Operation (Short idle)
12.58W
13.07W
12.65 W



100VAC COU-

## **Technical Specifications - Environmental**

Normal Operation (Long idle)	10.71 W	10.96W	10.79 W
Sleep	3.28 W	3.31W	3.26W
Off	1.15W	1.18 W	1.15 W
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	42.89 BTU/hr	44.59 BTU/hr	43.02 BTU/hr
Normal Operation (Long idle)	36.54 BTU/hr	37.39 BTU/hr	36.74 BTU/hr
Sleep	11.15 BTU/hr	11.29 BTU/hr	11.12 BTU/hr
Off	3.92 BTU/hr	3.99 BTU/hr	3.92 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

## HP Engage One Pro G2 AiO System Model 23.8" \*\*

Energy Consumption (in accordance with US ENERGY

STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	21.49W	21.55W	21.27W
Normal Operation (Long idle)	10.41W	10.52W	10.31W
Sleep	1.56W	1.55W	1.56W
Off	0.85W	0.86W	0.85W
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	42.89 BTU/hr	44.59 BTU/hr	43.02 BTU/hr
Normal Operation (Long idle)	36.54 BTU/hr	37.39 BTU/hr	36.74 BTU/hr
Sleep	11.15 BTU/hr	11.29 BTU/hr	11.12 BTU/hr
Off	3.92 BTU/hr	3.99 BTU/hr	3.92 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

<sup>\*\*</sup>TCO is only offered on the 23.8"

#### Technical Specifications - Environmental

#### **Longevity and Upgrading**

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 2 memory slots
- M.2 2230 slot for WLAN
- (1) M.2 2280 slot for SSD

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

**Batteries** 

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

#### **Additional Information**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <Gold> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 45.16% post-consumer recycled plastic (by wt.)
- This product is 96% recycle-able when properly disposed of at end of life.

**Packaging Materials** 

**Material Usage** 

External: PAPER/Corrugated

**Internal:** PLASTIC/Polyethylene Expanded – EPE

PLASTIC/Polyethylene low density - LDPE

The EPE foam packaging material is made from 100% recycled content.

The corrugated paper packaging materials contains at least 35% recycled content.

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds



#### **Technical Specifications - Environmental**

- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Notes: \* EPE foam packaging material is considered "recycled" pre-Consumer. The scrap or waste EPE material from the manufacturing process of these EPE foam pieces are re-introduced into the manufacturing process.

#### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP Inc. web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

## HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

PC Product Design ISO 14001 certificate

and

HP Operations ISO 14001 certificate



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

# QuickSpecs

## Technical Specifications - Environmental

#### **Footnotes**

<sup>1</sup>External power supplies, WWAN modules, power cords, cables and peripherals excluded. Service parts obtained after purchase may not be Low Halogen.

<sup>2</sup>Percentage of ocean-bound plastic contained in each component varies by product

<sup>4</sup>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.

<sup>6</sup>ITE Derived Closed Loop Plastic percentage is based on the definition set in the IEEE 1680.1-

2018 standard.



HP Engage One After Market Option Matrix

### **HP Engage One Pro Advance Hubs & cable AMOs**

AMO Part No. Description

9YH40AA#xxx HP Engage One Pro G2 Adv Fan-less Hub \*

156N6AA#xxx HP Engage One Pro G2 Adv Fan-less Hub White \*

\*Included 280W PSU/1.8M cord, need one of the separate cable below

2Z8M9AAHP Engage One Pro G2 2m USB-C® cable black2Z8N0AAHP Engage One Pro G2 0.5m USB-C® cable black2Z8N2AAHP Engage One Pro G2 2m USB-C® cable gray2Z8N1AAHP Engage One Pro G2 0.5m USB-C® cable gray

201A2AA HP Engage One Pro G2 Column/ VESA hub to Advance hub 2m black
201A1AA HP Engage One Pro G2 Column/ VESA hub to Advance hub 0.5m black
316D6AA HP Engage One Pro G2 Column/ VESA hub to Ad hub 2m gray
316D7AA HP Engage One Pro G2 Column/ VESA hub to Ad hub 0.5m gray

#### HP Engage One Pro G2 VESAHubs & cable AMOs

AMO Part No. Description

9YH42AA#xxx Engage One Pro VESAHub\*\*

#### Additional Cable available to connect the Column hub or the VESA hub to the Advance hub below

201A2AA HP Engage One Pro G2 Column/VESA hub to Advance hub 2m black 201A1AA HP Engage One Pro G2 Column/VESA hub to Advance hub 0.5m black

316D6AA HP Engage One Pro G2 Column/VESA hub to Ad hub 2m gray
316D7AA HP Engage One Pro G2 Column/VESA hub to Ad hub 0.5m gray

## **HP Engage One Pro G2 Mounting Option AMOs**

AMO Part No. Description

1A4E7AA Engage One Pro Slim VESA

326R7AA Engage One Pro Slim VESAWhite

9YH43AA Engage One Pro U-shaped Adapter

156N7AA Engage One Pro U-shaped Adapter White

1A4E5AA HP Engage One Pro G2 AiOStability Plate

1A4E6AA HP Engage One Pro G2 AiOStability Plate White



<sup>\*\*</sup>Included 230WPSU/ 1.8Mcord &cable

## **HP Engage One After Market Option Matrix**

2W7M4AA Engage One Pro Flexible Pole Single Mount 2W7M3AA Engage One Pro Flexible Back-to-Back Bracket **9YH51AA Engage One Pro Undercounter Mount** 

## **HP Engage One Pro G2 Mounting Option AMOs**

**Description AMO Part No.** 

2W7M4AA Engage One Pro Flexible Pole Single Mount 2W7M3AA Engage One Pro Flexible Back-to-Back Bracket

## **HP Engage One Pro G2 Customer Facing Displays (CFDs)**

AMO Part No.	Description
9YH48AA	HP Engage One Pro G2 6.6 inch Customer Facing Display
156N9AA	HP Engage One Pro G2 6.6 inch White Customer Facing Display
10P79AA	HP Engage 6.6 inch Pole Display
156N9AA	HP Engage 6.6 inch WPole Display
1 XD8 0 AA# ABA, # ABT, # AC3	HP Engage One 10 Display
1 XD8 1 AA# ABA, # ABT, # AC3	HP Engage One 10t Display
3 FH6 6 AN# ABA, # ABT, # AC3	HP Engage One 10w Display
3 FH6 7 AA# ABA, # ABT, # AC3	HP Engage One 10tw Display
20C49A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14 FHDMonitor
20C50A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14 FHDNo Stand Monitor
20C51A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14t FHDMonitor
20C52A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14t FHDNo Stand Monitor
2 D9 V5 AA# ABT, # AC3	HP Engage One 16t FHDMonitor
2 D9 X0 AA# ABT, # AC3	HP Engage One 16t FHDNo Stand Monitor
2 D9 Y5 AA# ABT, # AC3	HP Engage One 16ts FHDMonitor
2D9Z4AA#ABT, #AC3	HP Engage One 16ts FHDNo Stand Monitor

## HP Engage One Pro G2 Customer Facing Displays (CFDs) Stands

**Description** 

10P60AA HP Engage 6 Clean Mount Arm Bracket



AMO Part No.

## **HP Engage One After Market Option Matrix**

10P61AA	HP Engage 6 Stability Mount Arm Bracke
10P77AA	HP Engage 10 Clean Mount Stand
10P78AA	HP Engage 10 Stability Mount Stand
10P58AA	HP Engage 14 Clean Mount Stand
10P62AA	HP Engage 14 Stability Mount Stand

## **HP Integrated Peripherals AMOs**

AMO Part No.	Description
9YH50AA	HP Engage One Pro G2 Fingerprint Reader
2U551AA	HP Engage One Pro G2 Magnetic Stripe Reader
2V9G4AA	HP Engage One Pro G2 White Magnetic Stripe Reader
9YH49AA#AB4, #ABA, #ABB	HP Engage One Pro G2 Bar Code Scanner

## **HP All-in-One Adjustable Height Stand**

For Engage One Pro 23.8" All-in-One systems



**HP Engage One After Market Option Matrix** 



#### Model

HP All-in-One Adjustable Height Stand Black HP All-in-One Adjustable Height Stand White 518U6AA 518U7AA

#### Introduction

Optimize viewing of the Engage One Pro 23.8" All-in-One system with the HP All-in-One Adjustable Height Stand. Available in either black or white, this stand allows for height adjustment, tilt, and pan.

### **Key Features and Benefits**

- Position All-in-One for maximum ergonomic comfort—promotes wellness in any work area
- Small footprint frees up your workspace and increases your efficiency
- Integrated base rollers enable 360° rotation of the stand so you can share your views with others
- Features technology that enables light touch adjustments without levers or knobs
- Five-inch (13 cm) height adjustment (landscape mode) ergonomically accommodates average range of users
- Easy to use—simple installation and effortless operation
- Everything is included to neatly route cables behind the stand, out of the way
- IEC 62368-1 certified

## **Compatibility**



#### HP Engage One After Market Option Matrix

The HP All-in-One Adjustable Height Stands are compatible with the Engage One Pro 23.8" All-in-One system, both in portrait and landscape orientation, when an Engage One Pro VESA Mount or VESA Hub is configured on the system.

**Requirements**: The Engage One Pro VESA Mount or the Engage One Pro VESA Hub is required to mount the HP Engage One Pro G2 23.8" system onto the HP All-in-One Adjustable Height Stand. SKU options are listed below and are sold separately from the stand.

#### Drop-in-box SKUs (for configuration with HP Engage One Pro G2 system)

#### For black systems:

- HP Engage One Pro G2 AiO Slim VESA Mount (A30MJAV)
- HP Engage One Pro G2 AiO VESA Hub (A30MMAV)

#### For white systems:

- HP Engage One Pro G2 AiO Slim VESA Mount White (A30MKAV)
- HP Engage One Pro G2 AiO VESA Hub White (A30MNAV)

#### After-market option SKUs

#### For black systems:

- HP Engage One Pro G2 AiO Slim VESA Mount (1A4E7AA)
- HP Engage One Pro G2 AiO VESA Hub (9YH42AA)

#### For white systems:

- HP Engage One Pro G2 AiO Slim VESA Mount White (326R7AA)
- HP Engage One Pro G2 AiO VESA Hub White (326R6AA)

#### **Certifications:**

- IEC 62368-1:2014
- UL 62368-1, 2<sup>nd</sup> Ed. And CAN/CSA C22.2 No. 62368-1-14, 2<sup>nd</sup> Ed.

#### **Compliant with:**

- EN 62368-1:2014/ A11:2017
- BS EN 62368-1:2014/ A11:2017

### **Service and Support**

Three (3) year limited warranty with advance exchange when purchased from HP.

#### General

Lift (Height Adjust) in Landscape 5" (13 cm)

Mode

**Lift (Height Adjust) in Portrait** 2.5" (6.4 cm)

Mode

**Weight Capacity** 16-36 lb (7.3-16.3 kg)

**Monitor up/down tilt** Up to +25°/ -5° (depends on the height)

Pan 360°

Mechanical

**Product Weight** 13.8 lb (6.2 kg)

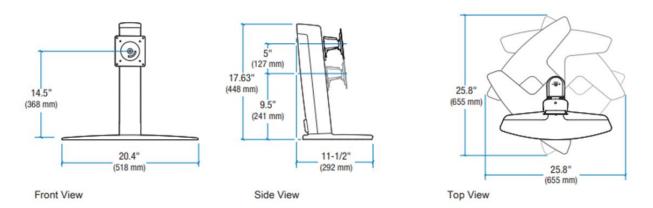
**Product Dimensions** 20.4" x 11.5" x 17.6" (51.8 cm x 29.2 cm x 44.8 cm)



## **HP Engage One After Market Option Matrix**

**Shipping Weight** 17.4 lb (7.9 kg)

**Shipping Dimensions** 23" x 13" x 7.3" (58.5 cm x 33.0 cm x 18.5 cm)



#### **Box Contents**

Base, stand, monitor mounting bracket, screws, weight adjustment tool, cable ties, quick-setup manual

## **HP Engage 6.6 inch Customer Facing Display**



### Model

HP Engage 6.6 inch Customer Facing Display
HP Engage 6.6 inch Customer Facing Display White

9YH48AA 156N8AA



## HP Engage One After Market Option Matrix

### Introduction

Give customers a clear view of their transactions and sharing engaging, colorful, dynamic content at the point of sale with LCD touch display.

## **Key Benefits**

- 6.6 inch diagonal compact LCD display that integrates easily into your retail solution.
- Position as need with adjustable height and swiveling of the display head.
- Place the durable, dust resistant display in a range of high traffic areas.
- A USB connector powers the display and eliminated the need for additional cabling.
- The edge to edge, bezel free 63 esign is easy to clean, helps protection from dust, and create a sleek, modern appearance.



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

# QuickSpecs

Overview - After Market Options

# **Compatibility**

The HP Engage 6.6 inch Customer Facing Display is compatible with HP Retail Point of Sale Systems.

**NOTE:** Not all Point of Sale system models are available in all regions.

# **Service and Support**

Three (3) year limited warranty with advance exchange when purchased from HP.



### Overview - After Market Options

#### General

Display MethodBacklit LEDBrightness400 NitsResolution1440 x 720

 Pixel Pitch
 0.105 x 0.105 mm

 Active Area
 75.6 (H) x 151.2 (V) mm

Contrast Ratio 1000:1 (max)

**Response Rate** 25 ms (rise+fall time)

Viewing Angle Left: 85°

Right: 85° Top: 85° Bottom: 85°

**Color Gamut** 70% (CIE 1931 Standard NTSC)

Mechanical

**Display Dimensions** 

(WxHxD)

171.4 x 76.2 x 56.35 mm

**Display Weight** 0.25 kg

Hinge Adjustability Rotation Range 0°~90° (normal using)

Folded to 90° for shipping

Color HP Black / White

Connection

Interface USB

**Power** 

Operating Voltage 5V

Full Load Current 6.5W (DC +5V, 1300mA)

Idle Current 0.64W TBD

**Temperature Range** 

**Operating** 0°C to 35°C [32 to 95°F] at 10% to 90% humidity (non-condensing)

Non-operating -30°C to 65°C [-22 to 149°F] at 0% to 95% humidity (38.7°C maximum wet bulb

temperature)

**Webcam** 30fps USB 2.0 webcam, 5MP (2560x1920) resolution

NOTE: The Integrated webcam is a windows Hello Camera and IR is supported on 5MP

Camera

**Operating System** 

**Compatible with:** Windows 11 Pro 64-bit

Windows 10 Professional 64-bit) Windows 10 IoT Enterprise 2021 LTSC Windows 10 IoT Enterprise 2019 LTSC

Android™ 11 Android™ 11 AOSP Android™ 11 GMS FreeDos 2.0

SUSE Linux® Enterprise Server 15

**Kit Contents** 

HP Engage 6.6 inch Customer Facing Display, documentation, warranty card.



Overview - After Market Options

### **HP Engage One Pro G2 Integrated Barcode Scanner**





#### Model

HP Engage One Pro G2 Integrated Barcode Scanner Configure to Order (CTO) with HP Engage HP Engage One Pro G2 Integrated Barcode Scanner After-market option (AMO) B3WY5AV (bottom), B3WY8AV (left), B3WZOAV (right) B6BP1AA

### Introduction

This integrated scanner streamlines your checkout area, while offering placement options, acceptance of various barcodes and coupons, and enhanced features for an easier, more accessible checkout experience.

# **Key Features and Benefits**

- Enjoy a configurable, clutter-free scanning space. Our new integrated barcode scanner inserts into the left, right, or bottom of the HP Engage One Pro G1 AiO or HP Engage One Pro G2 AiO for a sleek, seamless look.
- Quickly scan mobile wallets and digital coupons from customer mobile devices or printed 1D and 2D barcodes, or validate customer identity with passport OCR.
- Enable both employees and customers alike to scan items with ease. The unit reads barcodes when they're placed within 1.2" to 18.5" \*inches from the scanner.
- Minimize fatigue by adjusting the scan light for your ambient lighting conditions—lower the brightness in darker environments and increase in brighter environments.
- Choose to have the barcode scanner included when you purchase your HP Engage One Pro G2 AiO, or add it on later as you
  need the upgrade. \*\*
- The HP Engage One Pro G2 AiO flip- sensing feature will turn off the LED when the head unit is flipped.
- Enjoy support for your retail operating system of choice. The HP Engage One Pro G2 Integrated Barcode Scanner supports Windows 11, Windows 10, Windows IoT, Linux®, and Android-based systems.
- Rest easy that your IT investment is supported by a three- year standard limited warranty.

\*Min/max reading distance vary for different symbologies/densities.

\*\*Optional feature sold separately or as an add-on feature.

# Compatibility



### Overview - After Market Options

The HP Engage One Pro G2 Integrated Scanner is compatible with the HP Engage One Pro All-in-One system and the HP Engage One Pro G2 All-in-One system.

**NOTE:** Not all Point of Sale systems are available in all regions.

## **Service and Support**

Three (3) year limited warranty with advance exchange when purchased from HP.

#### General

Image Sensor 1200 x 800 CMOS

Illumination Aimer White LED

Red LED 625± 10nm

Depth of Field Typical Performance \*

Symbologies Depth of Field

EAN-13 50mm-470mm (13mil)
Code39 55mm-260mm (5mil)
PDF-417 60mm-190mm (6.7mil)
Data Matrix 43mm-240mm (10mil)
OR Code 30mm-320mm (15mil)

**Symbol Contrast** 25% minimum reflectance

 Roll (tilt)
 360°

 Pitch
 ±60°

 Skew
 ±60°

Field of View Horizontal 47°, Vertical 30°

**1D decode symbologies** Autodiscriminates all standard 1D codes including GS1 DataBar™ linear codes.

AIM 128 China Post 25 Codabar Code 11 Code 39 Code 49 Code 93 Code 128 Code 16K Coupon EAN-8 EAN-13

Febraban

GS1-128 (UCC/EAN-128)

**GS1 Composite (EAN UCC Composite)** 

GS1 Databar (RSS) Industrial 25 Interleaved 2 of 5

ISBN ISBT 128 ISSN ITF-6 ITF-14 Matrix 25 MSI-Plessey



### Overview - After Market Options

Plessey Standard 25 UPC-A UPC-E

2D decode symbologies Aztec Code

Chinese Sensible Code

Code One **Data Matrix GM Code** MaxiCode MicroPDF417 Micro OR Code **PDF417** OR Code

Postal decode **Australian Post** symbologies KIX Post

Royal Mail

**USPS Intelligent Mail** 

**USPS Planet USPS** Postnet Passport OCR

**OCR** symbologies

Mechanical

Dimensions ( $W \times D \times H$ ) 30.7 x 45.0 x 10.1 mm (Maximum)

Weight 9.6q Color Black

Interface/Connection

Interface **USB** 

**Temperature** 

**Operating** -20°C to 40°C (-4°F to 104°F) -40°C to 70°F (-40°F to 158°F) Storage

**Humidity (non-**5% to 95% condensing)

**Power** 

Operating Voltage 5VDC±5%

**Current at 5VDC** Operating: 300mA (RMS typical), 450mA (RMS max.)

Idle: <50mA (level mode), <135mA (sense mode)

Sleep: <1.5mA

**Rated Power Consumption** 1.5 W Typical

**Drivers** Windows USB HID-KB and OPOS & JPOS (via USB-COM mode drivers)

0-100,000 lux **Ambient Light** 

**Water Penetration Protection** IP54

**Operating System** 

Compatible with: **Windows** Windows 11

Windows 10 Pro 64bit

Windows 10 IoT Enterprise 2016 LTSB 64bit (RS1) Windows 10 IoT Enterprise 2019 LTSC 64bit (RS5)

Linux



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

# QuickSpecs

# Overview - After Market Options

Red Hat/CentOS 5.6.8 and above (64 bit) Suse Linux Enterprise 11/12 SP3 and above (64 bit) Ubuntu 12.04/14.04 LTS and above (64 bit)

#### **Android**

Android 8.0 and above

#### **Agency Certifications**

FCC Part15, Class B, CE EMC Class B, IEC62471, RoHS, IEC 62368-1, AfPS GS 2019, EK1-ITB 2000, UL, CNS13438

#### **AMO Kit Contents**

HP Engage One Pro G2 Integrated Barcode Scanner, documentation, warranty card



Overview - After Market Options

## **HP Engage One Magnetic Stripe Reader**





### Model

HP Engage One Pro G2 Magnetic Stripe Reader HP Engage One Pro G2 White Magnetic Stripe Reader 2U551AA 2V9G4AA

### **Compatibility**

The HP Engage One Pro G2 Magnetic Stripe Reader is compatible with the HP Engage One Pro G2 All-in-One System.

**NOTE:** Not all Point of Sale system models are available in all regions.

# **Service and Support**

Three (3) year limited warranty with advance exchange when purchased from HP.

### Overview - After Market Options

#### General

Magnetic stripe formats ISO 7811, AAMVA

**Card Thickness** 0.38 to 1.14 mm (0.015 to 0.045 in)

**Indicators** Bi-colored LED, beeper (requires system audio driver)

**Card Speed** 3 to 75 ips (7.6 to 190.5 cm/s)

Mechanical

Weight 5.67 g

**Slot width** 1.14 mm (0.045 in)

Color HP Black HP White

Connection

Interface Eight-pin male Molex 51021-0800

**Cable Length**  $125 \pm 6.4 \text{ mm}$ 

**Power** 

Power Supply 3.0 to 3.6 VDC I/O Voltage Range 2.7 to 3.6 VDC

Active Power Supply 5

Current

mA Standby Power 0.03 mA

**Supply Current** 

**Temperature Range** 

**Operating** 0°C to 55°C

**Relative Humidity** -10% to 90% non-condensing

Reliability

**Operating Life** 1,000,000 card swipes minimum

**Agency Certifications** 

FCC, CE, USB-IF

**Operating Systems** 

**Compatible with:** Windows 11 Pro 64-bit

Windows 10 Professional (64-bit) Windows 10 IoT Enterprise 2021 LTSC Windows 10 IoT Enterprise 2019 LTSC

Android™ 11 Android™ 11 AOSP Android™ 11 GMS FreeDOS 2.0

SUSE Linux® Enterprise Server 15

**Kit Contents** 

HP Engage One Pro G2 Magnetic Stripe Reader, documentation, warranty card.



Overview - After Market Options

## **HP Engage One Pro G2 Fingerprint Reader**



### Model

HP Engage One Pro G2 Fingerprint Reader

9YH50AA

# **Compatibility**

The HP Engage One Pro G2 Fingerprint Reader is compatible with the HP Engage One Pro G2 All-in-One System.

# **Service and Support**

Three (3) year limited warranty with advance exchange when purchased from HP.

### Overview - After Market Options

#### General

Sensor Type Capacitive

Array Size 208 x 288 pixels

**Image Resolution** 508 DPI

**Gray Scale** 8-bit (256 levels)

Mechanical

Image Area10.4 x 14.4 mmImage/CoatingSteel CoatColorHP Black

**Digital ID Reliability** 

NVM Storage 100 templates
Data Retention 20 years
Erase/Write 100,000 cycles

Interface/Connection

Interface USB 2.0

Interface Connector 5 pin, 0.8mm pitch wire-type (gold-plated)

Temperature

 Operating
 -30° to +85°C

 Storage
 -40° to +85°C

 Humidity (non 5% to 85%

condensing)

**ESD Tolerance** IEC 61000-4-2 Level 4

**Power** 

**Consumption** Supply voltage: single supply voltage, 3.0V to 3.6V

Imaging mode: 105 mA @ 3.3V Sleep mode: 1350 uA @ 3.3V

**Wake-up Time** < 15 ms (Sleep to imaging)

**Drivers** 

Windows USB HID-KB and OPOS & JPOS (via USB-COM mode drivers)

**Operating Systems** 

**Compatible with:** Windows 11 Pro 64-bit

Windows 10 Professional (64-bit) Windows 10 IoT Enterprise 2021 LTSC Windows 10 IoT Enterprise 2019 LTSC

Android™ 11 Android™ 11 AOSP Android™ 11 GMS FreeDOS 2.0

SUSE Linux® Enterprise Server 15

**Agency Certifications** 

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Kit Contents** 

HP Engage One Pro G2 Fingerprint Reader, documentation, warranty card.



### Overview - After Market Options

### Service and Support

Ninety-day (90-90-90), one-year (1-1-1), and three-year (3-3-3) limited warranty delivers (ninety days/one year/three years) of on-site, next business day<sup>2</sup> service for parts and labor and complimentary limited technical support.<sup>3</sup> Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack.<sup>1</sup> To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc

#### **NOTES:**

- 1. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
- 2. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- 3. Technical support applies only to HP-configured Compaq and third-party HP-qualified hardware and software. 24 x 7 support may not be available in some countries.

Date of change:	Version History:		Description of change:
January 27, 2025	From v1 to v2	Changed	Format



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